G2K30Z0_V1.1

CPU:

LOONGSON 2K3000

MEM:

DDR4 SODIMM

EMMC 32GB

NVME SSD

Other:

MINI-PCIE SLOT

SATA SLOT

LAN *2

DP

HDMI

EDP

USB3.0&USB2.0

TF SLOT

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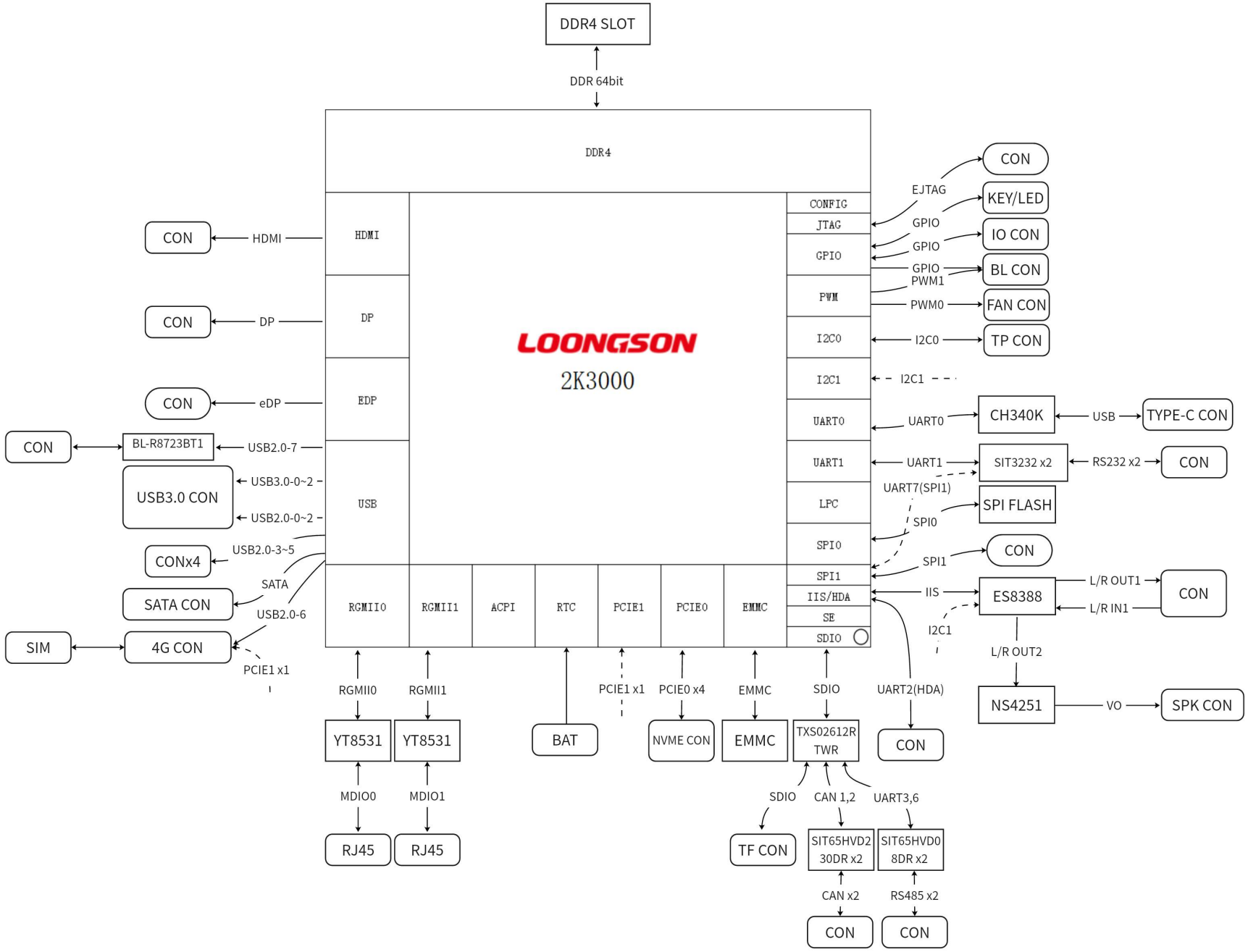
北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

板卡名称	G2K30Z0_V1.1		
Size C	部门 广东龙芯		Rev 1.1
Date: Wednesday, June 11, 2025		Sheet 1 of 24	
Drawn By <OrgAddr1>		Checked By <OrgAddr2>	

BLOCK DIAGRAM



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北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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SYSTEM RESOURCE

GPIO CONFIG

PIN NAME	REUSE	I/O	NOTE
LPC_LAD0	GPIO56	O	TF card multiplexing function switching
LPC_LAD1	GPIO57	I	User-defined buttons
LPC_LAD2	GPIO58	O	mini PCIE reset function
LPC_LAD3	GPIO59	O	FRONT LINEOUT1 sw
LPC_CLKOUT	GPIO60	O	Beep control
LPC_FRAMEn	GPIO61	O	TP reset
LPC_RESETn	GPIO62	O	NS4251 shutdown
LPC_SIRQ	GPIO63	O	Infrared detection input
PWM0	GPIO50	O	FAN control
PWM1	GPIO51	O	BACKLIGHT en
PWM2	GPIO52	O	BACKLIGHT adj
GPIO0	GPIO0	I	Headset insertion detection
GPIO1	GPIO1	O	Watch dog input
GPIO2	GPIO2	I	TP Interrupt in
GPIO3	GPIO3	O	Watch dog set
CPU_ACPI_GPIO0	ACPI_GPIO0	O	NC
CPU_ACPI_GPIO1	ACPI_GPIO1	O	NC
CPU_ACPI_GPIO2	ACPI_GPIO2	I	BOOT KEY
CPU_ACPI_GPIO3	ACPI_GPIO3	O	CAN-FD EN

IIC CONFIG

IIC	FUNCTIONAL	Address(7-BIT)
I2C0	GPU voltage regulation control	0x2F
	NODE voltage regulation control	0x0F
	EEPROM	0x54
	DDR4 DIMM SPD ROM	0x50
I2C1	ES8388	0x10
	RTC	0x32
	I2C expansion	TBD

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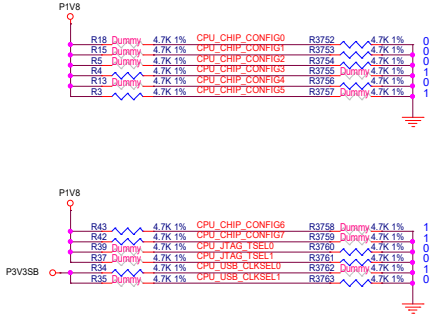
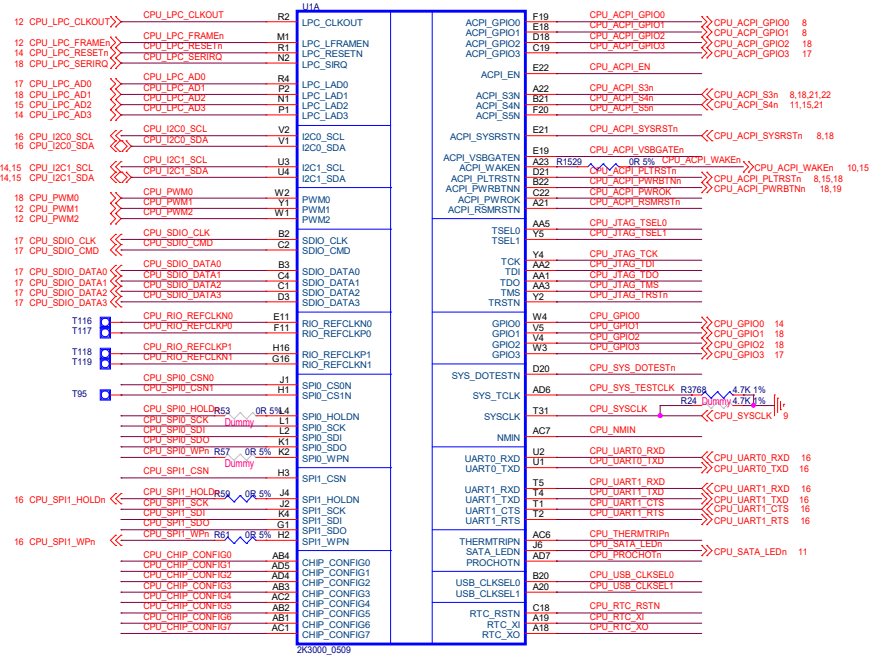
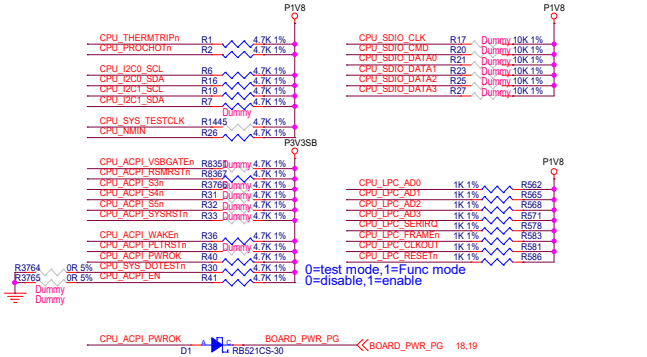
CFG/ACPI/IO/MISC

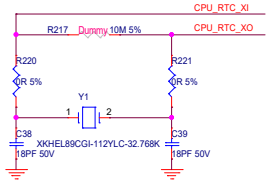


CPU CONFIG

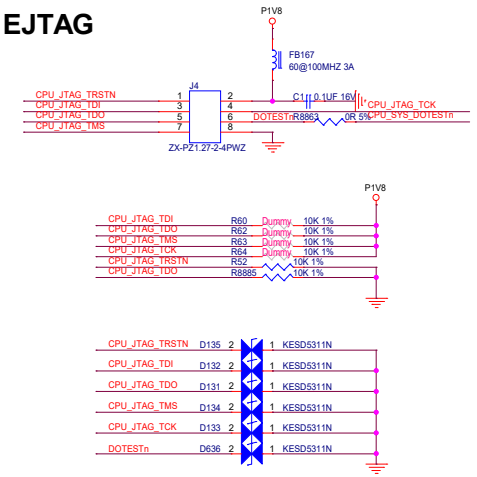
PIN NAME	INTER PU/PD	CONFIG
CHIP_CONFIG0	PD	系统时钟选择输入: **0=SYS_CLKIN**,1=PHY输出时钟
CHIP_CONFIG1	PD	PRG 参考时钟选择: **0=选择 USB3 输出的25MHz 参考时钟** 1=选择 PCIE_REFCLKp/n 作为参考时钟
CHIP_CONFIG2	PU	clk_sel0: 1, **0**
CHIP_CONFIG3	PD	clk_sel1: **1**, 0
CHIP_CONFIG4	PD	SE enable: 1=enable, **0=disable**
CHIP_CONFIG5	PD	GPU enable: **1=enable**, 0=disable
CHIP_CONFIG6	PD	保留
CHIP_CONFIG7	PD	保留
TSEL0	PD	JTAG 模式选择 0: 1, **0**
TSEL1	PD	JTAG 模式选择 1: 1, **0**
USB_CLKSEL0 USB_CLKSEL1		USB时钟选择: 00=25MHz 晶体，驱动能力 0; **01=25MHz 晶体，驱动能力 1;单端时钟** 10=25MHz 单端输入；11=25MHz 差分输入

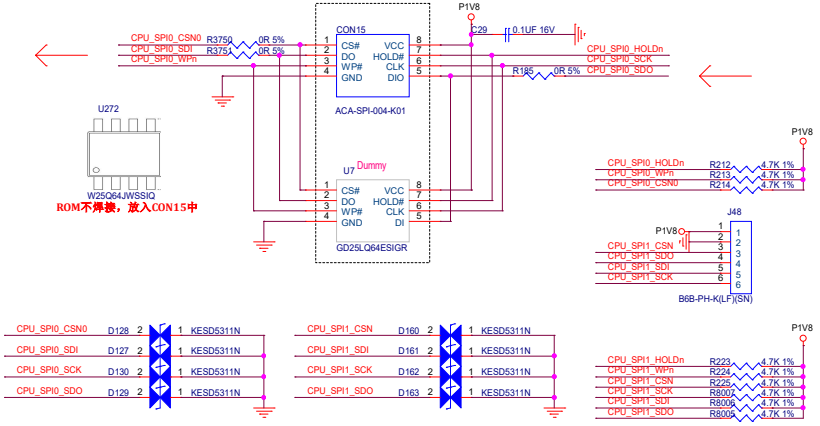


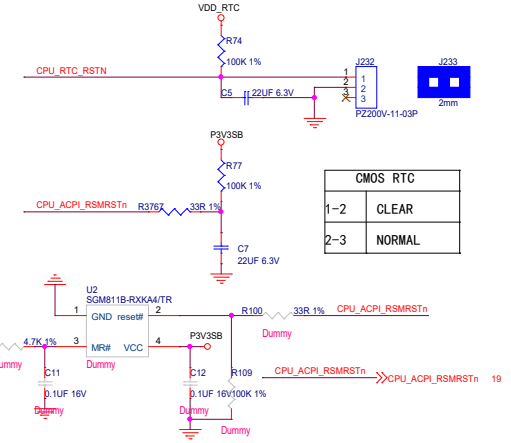




EJTAG







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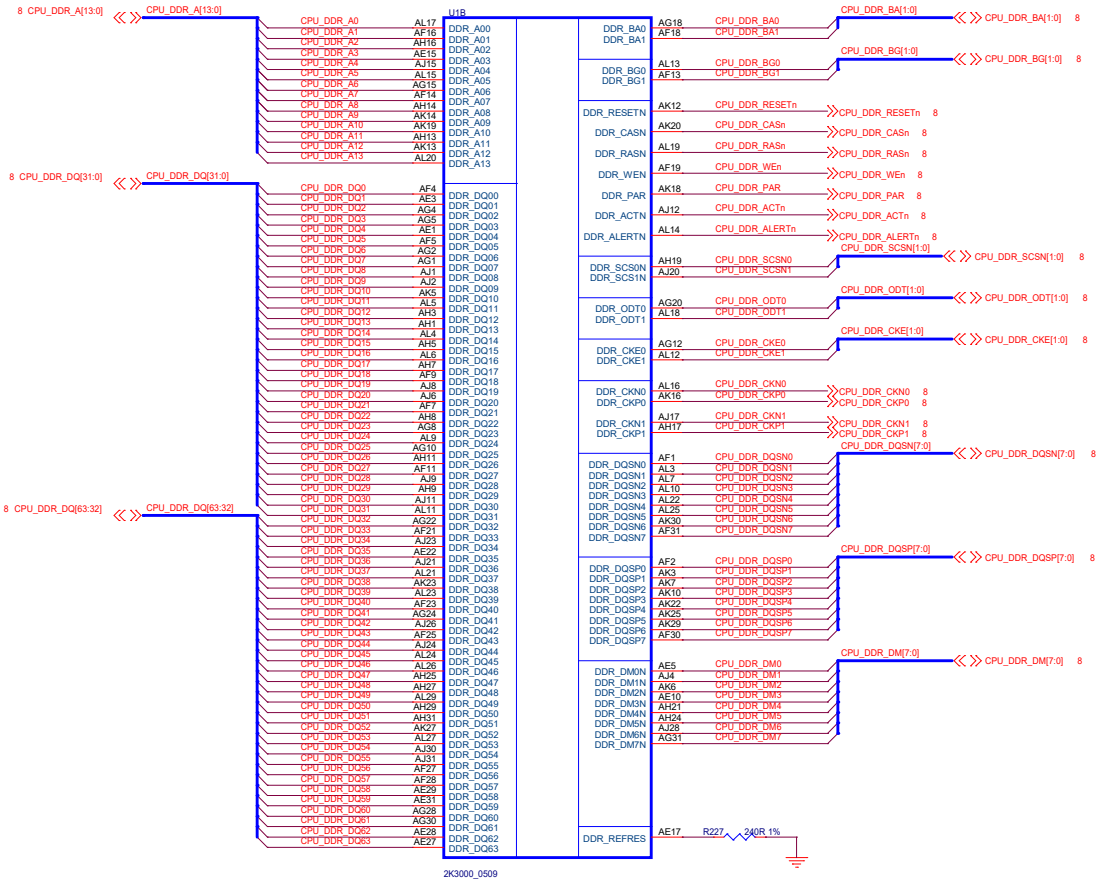
DDR



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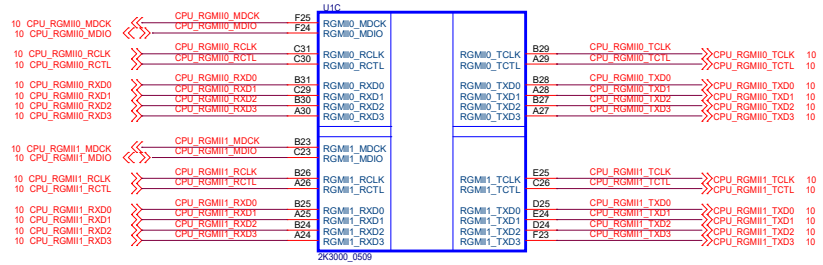
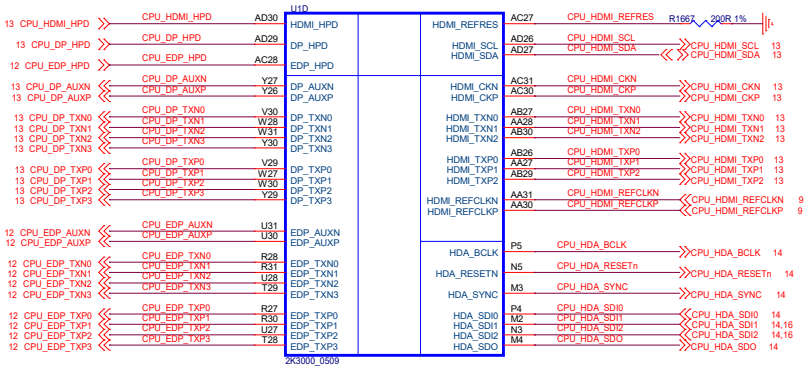
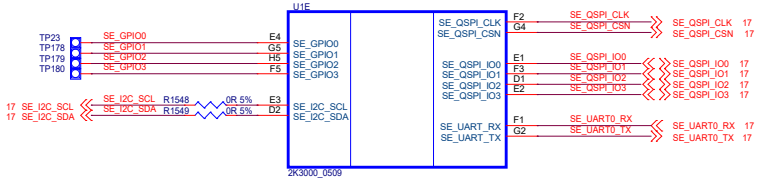
RGMII0/1



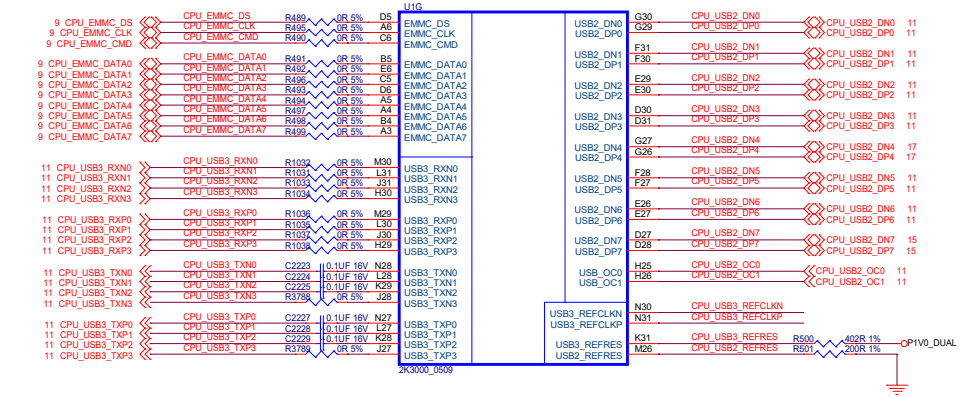
HDMI/DP/EDP/HDA/IIS



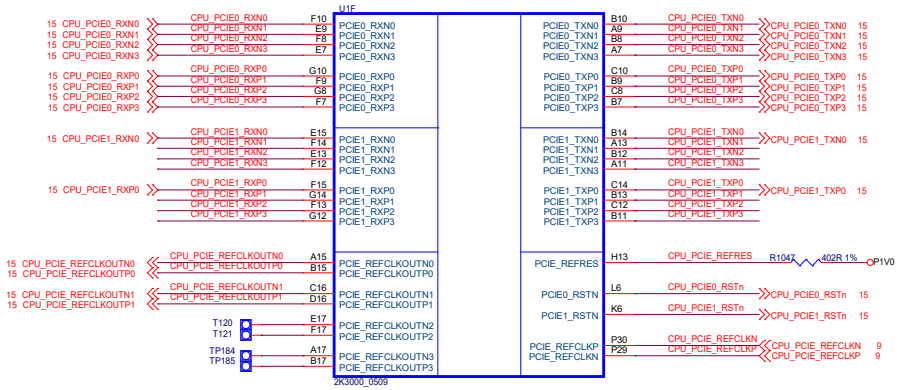
SE

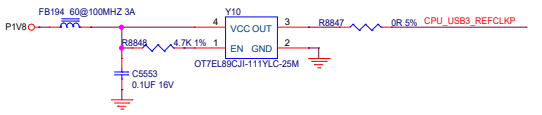


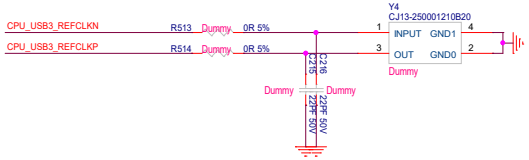
EMMC/USB3.0/USB2.0



PCIE0/1







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北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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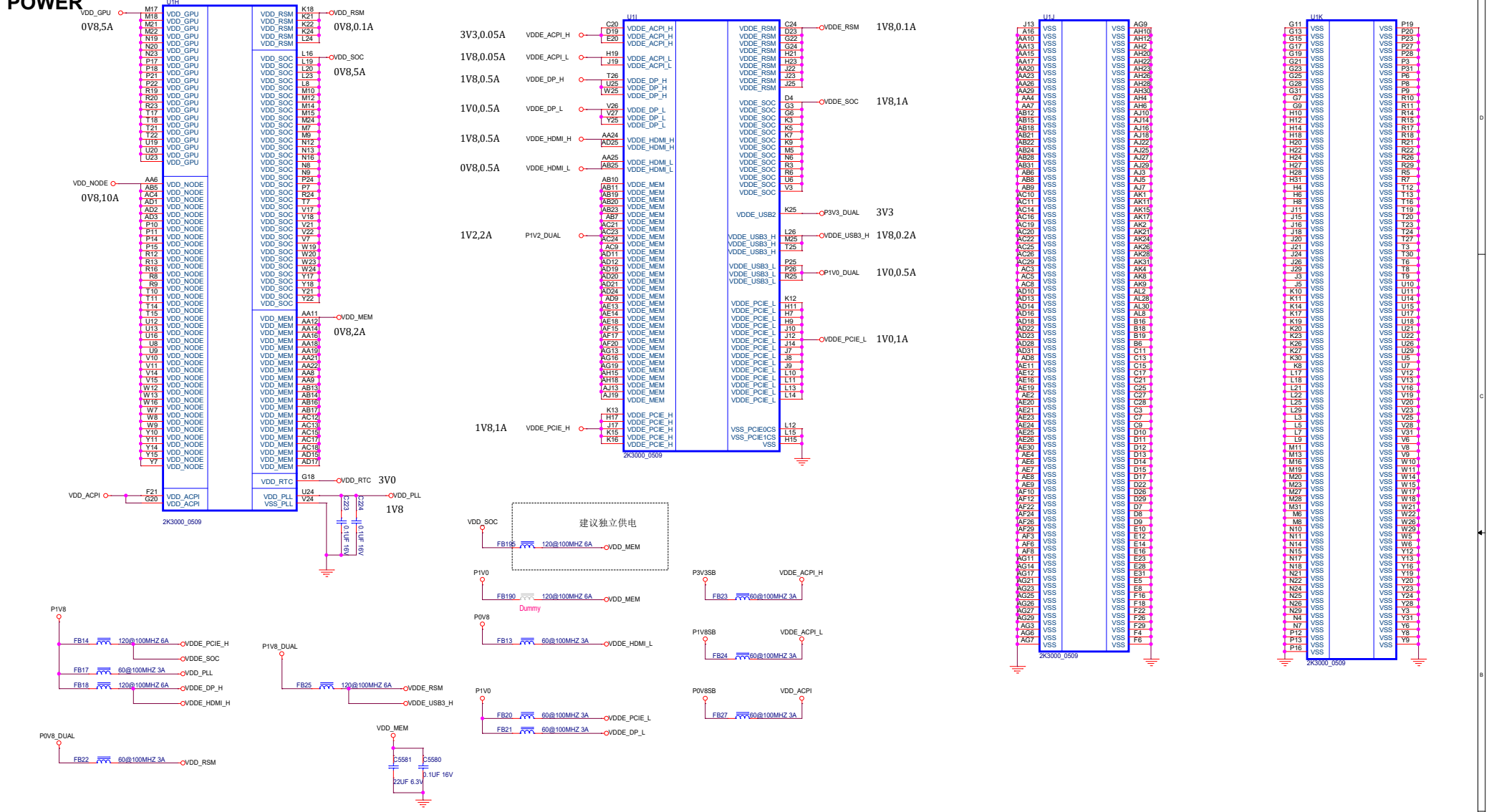
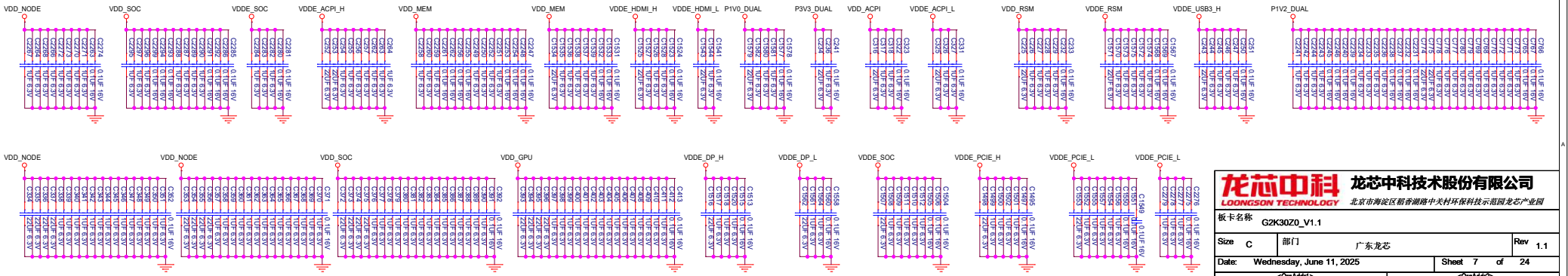
POWER





龙芯中科 LOONGSON TECHNOLOGY	龙芯中科技术股份有限公司 北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园		
板卡名称	G2K30Z0_V1.1		
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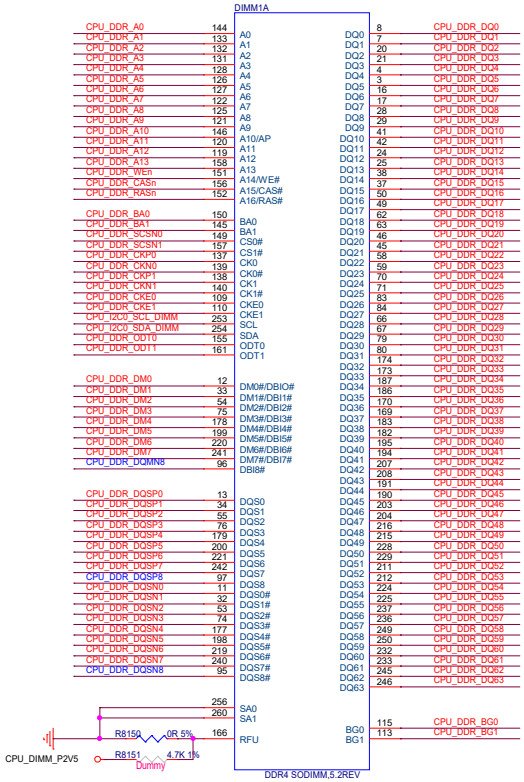
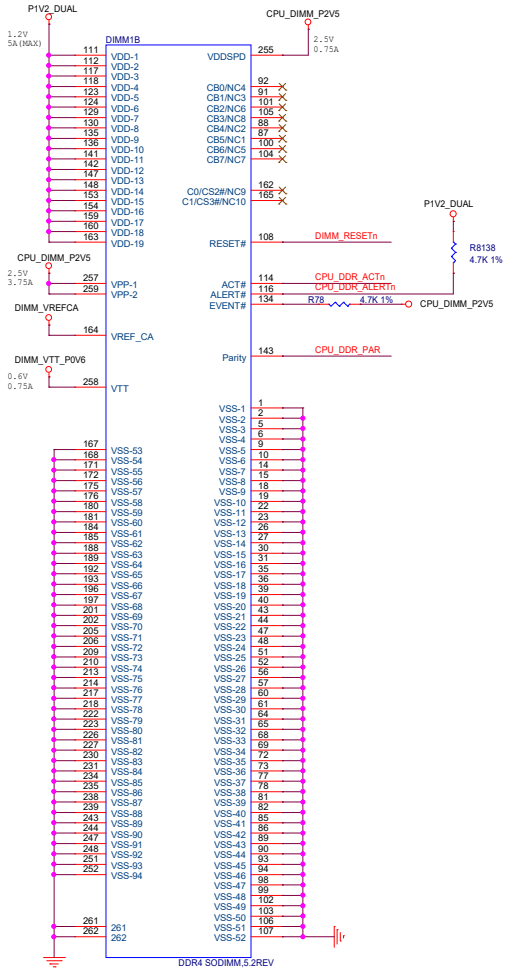
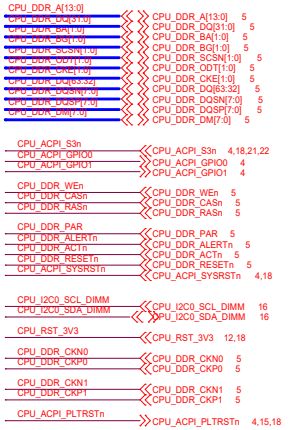
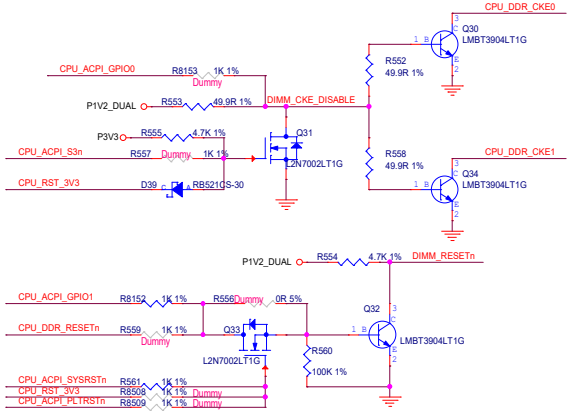
DDR4 SODIMM

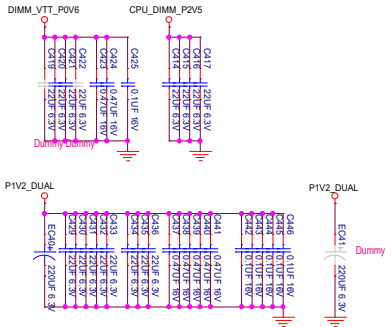


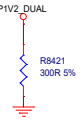
I2C Address: 1010 000x

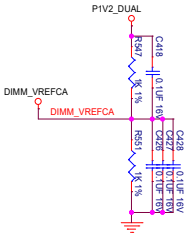












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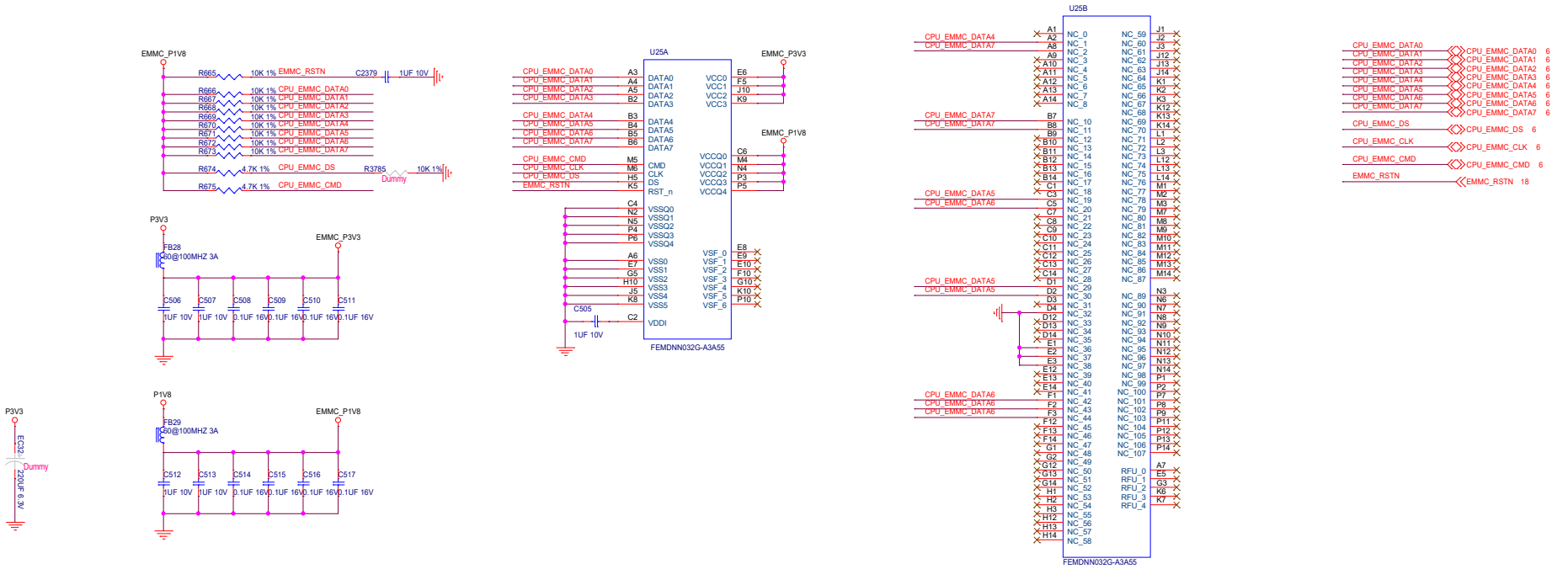
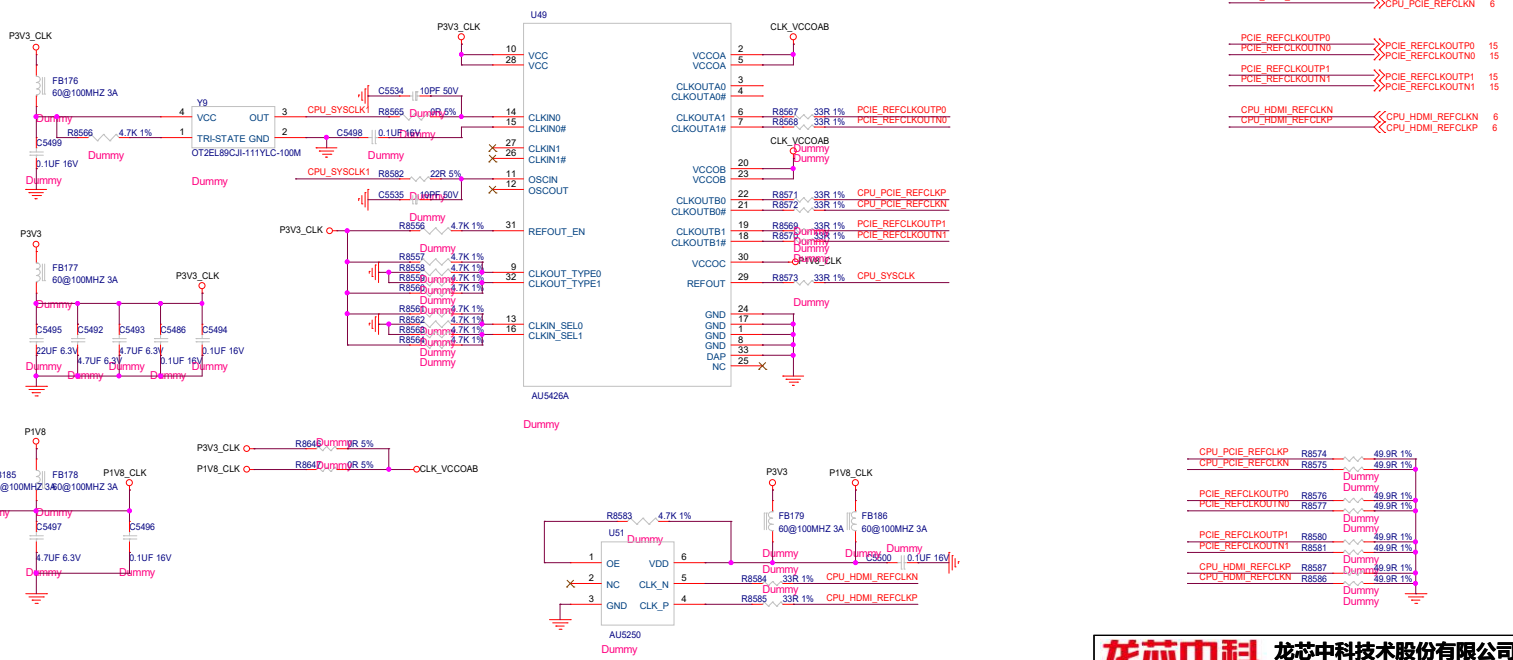
EMMC



CLOCK



Output Driver Type

Clock_tpye1	Clock_tpye0	CLK Buffer Type
0	0	LVPECL
0	1	LVDS
1	0	HCSL
1	1	HIZ

Input Clock Selection

CLKin_SEL1	CLKin_SEL0	Selceted Clock
0	0	CLKIN0, CLKIN0*
0	1	CLKIN1, CLKIN1*
1	0	Crystal Or Crystal bypass AC coupled mode
1	1	Crystal bypass DC coupled mode

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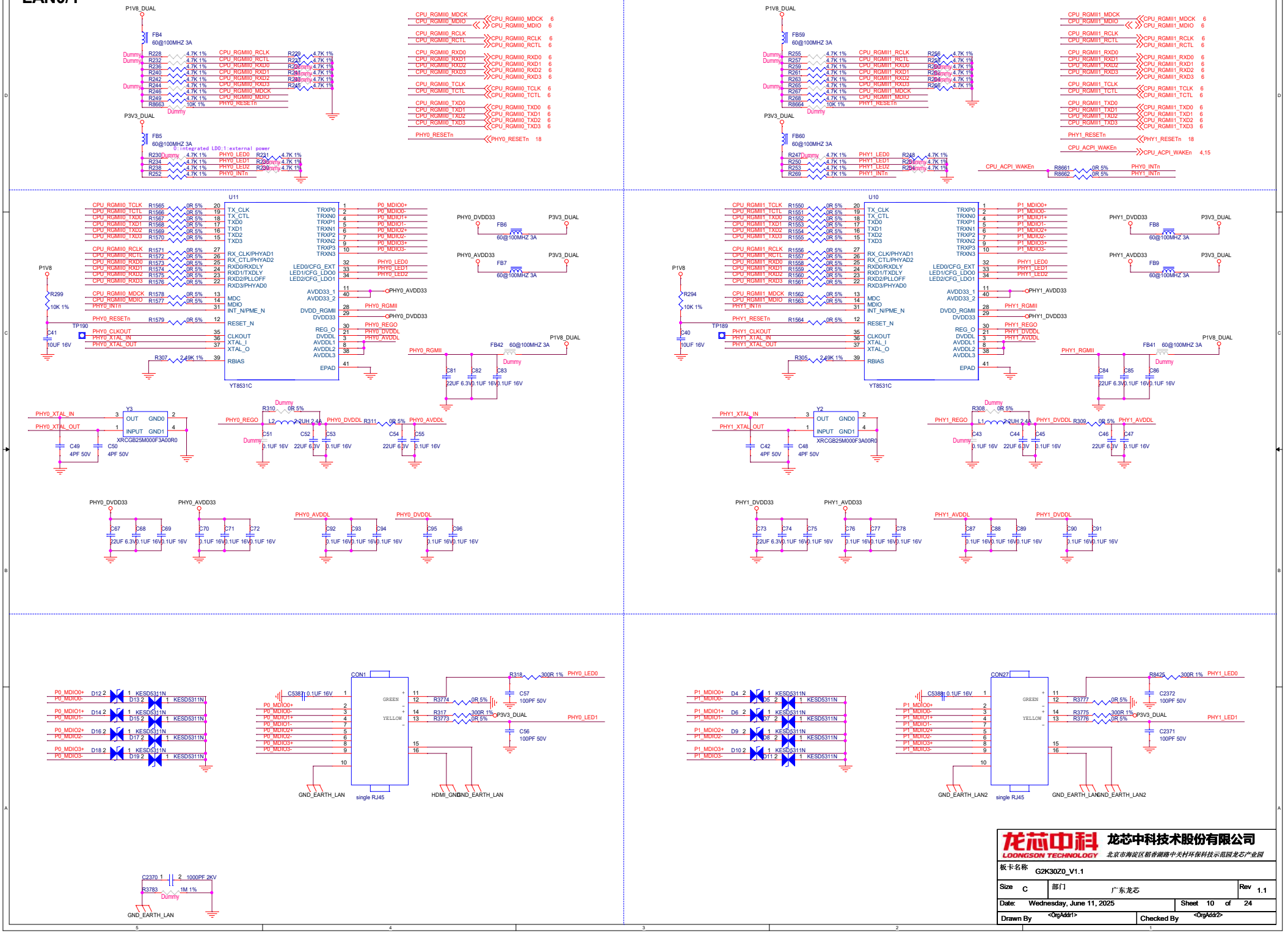
LAN0/1


P1V8_DUAL
FB4
60@100MHZ 3A
P3V3_DUAL
FB5
60@100MHZ 3A
0:integrated LD0;1:external power
CPU_RGMII0_MDCK
CPU_RGMII0_MDIO
CPU_RGMII0_RCLK
CPU_RGMII0_RCTL
CPU_RGMII0_RXD0
CPU_RGMII0_RXD1
CPU_RGMII0_RXD2
CPU_RGMII0_RXD3
CPU_RGMII0_TCLK
CPU_RGMII0_TCTL
CPU_RGMII0_TXD0
CPU_RGMII0_TXD1
CPU_RGMII0_TXD2
CPU_RGMII0_TXD3
PHY0_RESETn
PHY0_LED0
PHY0_LED1
PHY0_LED2
PHY0_INTn
P1V8_DUAL
FB59
60@100MHZ 3A
P3V3_DUAL
FB60
60@100MHZ 3A
CPU_RGMII1_MDCK
CPU_RGMII1_MDIO
CPU_RGMII1_RCLK
CPU_RGMII1_RCTL
CPU_RGMII1_RXD0
CPU_RGMII1_RXD1
CPU_RGMII1_RXD2
CPU_RGMII1_RXD3
CPU_RGMII1_TCLK
CPU_RGMII1_TCTL
CPU_RGMII1_TXD0
CPU_RGMII1_TXD1
CPU_RGMII1_TXD2
CPU_RGMII1_TXD3
PHY1_RESETn
CPU_ACPI_WAKEn
PHY1_LED0
PHY1_LED1
PHY1_LED2
PHY1_INTn
U11
YT8531C
TX_CLK
TX_CTL
TXD0
TXD1
TXD2
TXD3
RX_CLK/PHYAD1
RX_CTL/PHYAD2
RXD0/RXDLY
RXD1/TXDLY
RXD2/PLLOFF
RXD3/PHYAD0
LED0/CFG_EXT
LED1/CFG_LDO0
LED2/CFG_LDO1
MDC
MDIO
INT_N/PME_N
RESET_N
CLKOUT
XTAL_I
XTAL_O
RBIAS
EPAD
TRXP0
TRXN0
TRXP1
TRXN1
TRXP2
TRXN2
TRXP3
TRXN3
AVDD33_1
AVDD33_2
DVDD_RGMII
DVDD33
REG_O
DVDDL
AVDDL1
AVDDL2
AVDDL3
P0_MDIO0+
P0_MDIO0-
P0_MDIO1+
P0_MDIO1-
P0_MDIO2+
P0_MDIO2-
P0_MDIO3+
P0_MDIO3-
PHY0_LED0
PHY0_LED1
PHY0_LED2
PHY0_AVDD33
PHY0_RGMII
PHY0_DVDD33
PHY0_REGO
PHY0_DVDDL
PHY0_AVDDL
PHY0_CLKOUT
PHY0_XTAL_IN
PHY0_XTAL_OUT
PHY0_DVDD33
PHY0_AVDD33
PHY0_AVDDL
PHY0_DVDDL
U10
YT8531C
P1_MDIO0+
P1_MDIO0-
P1_MDIO1+
P1_MDIO1-
P1_MDIO2+
P1_MDIO2-
P1_MDIO3+
P1_MDIO3-
PHY1_LED0
PHY1_LED1
PHY1_LED2
PHY1_AVDD33
PHY1_RGMII
PHY1_DVDD33
PHY1_REGO
PHY1_DVDDL
PHY1_AVDDL
PHY1_CLKOUT
PHY1_XTAL_IN
PHY1_XTAL_OUT
PHY1_DVDD33
PHY1_AVDD33
PHY1_AVDDL
PHY1_DVDDL
CON1
CON27
single RJ45
GND_EARTH_LAN
HDMI_GND
GND_EARTH_LAN2
龙芯中科技术股份有限公司
北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园
板卡名称 G2K30Z0_V1.1
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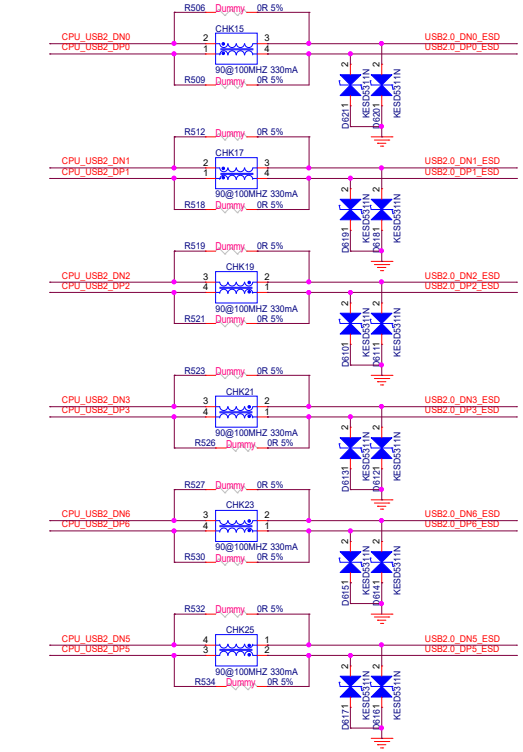
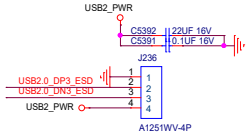
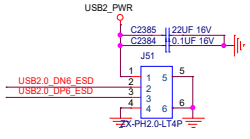
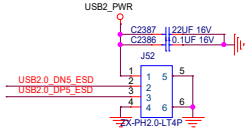
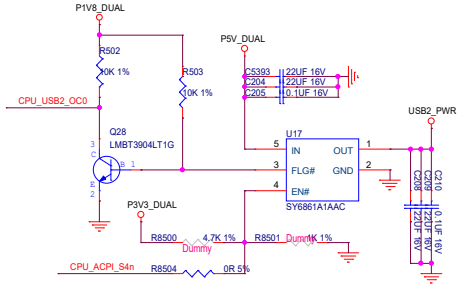
USB2.0



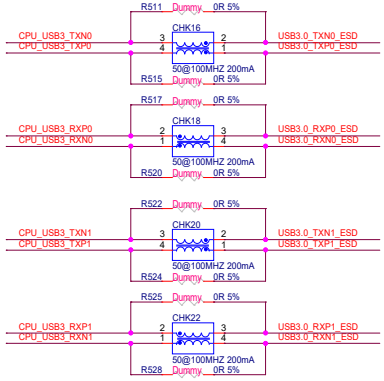


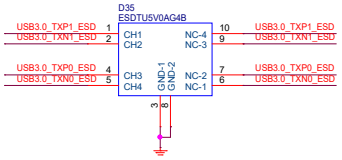


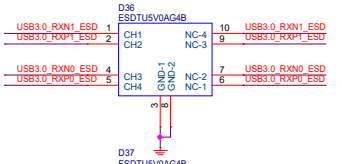


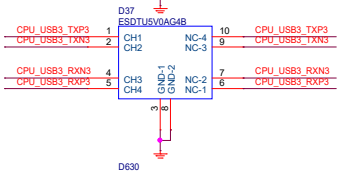


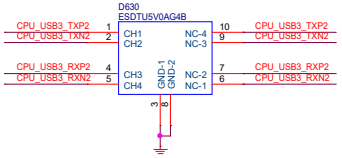
USB3.0

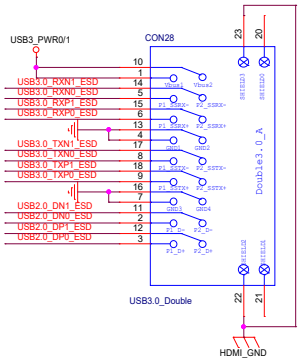


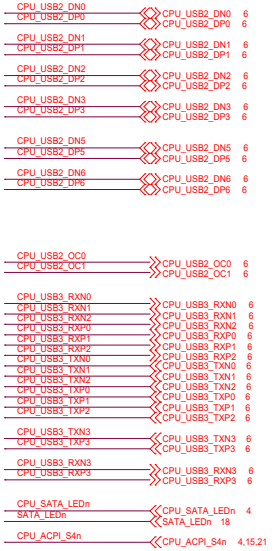


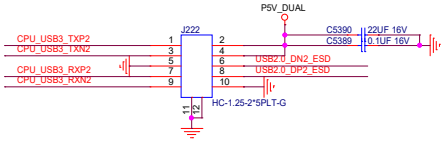


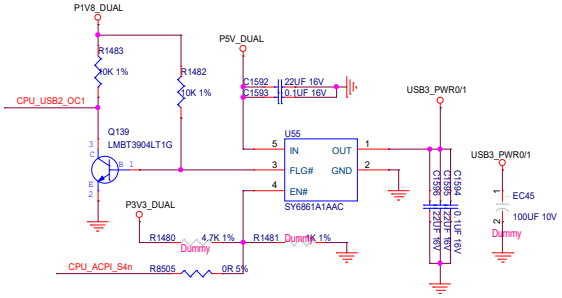




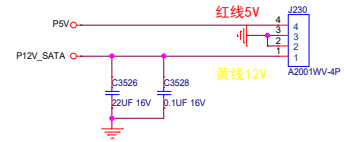


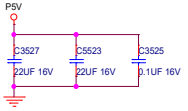


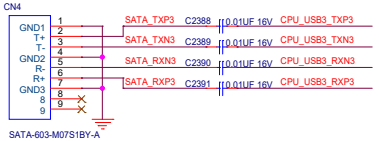


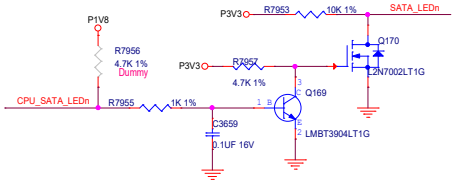


SATA









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北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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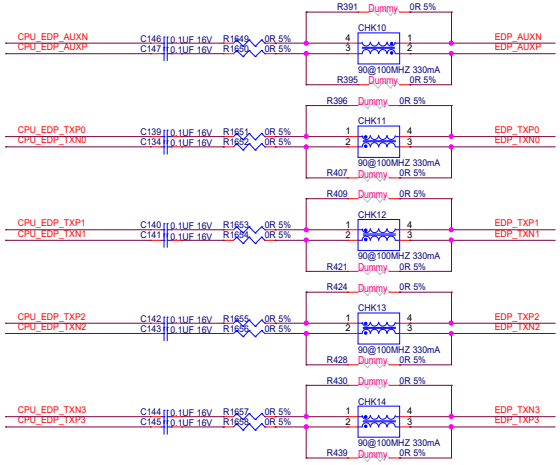
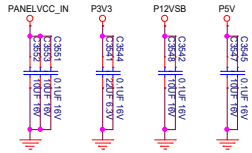
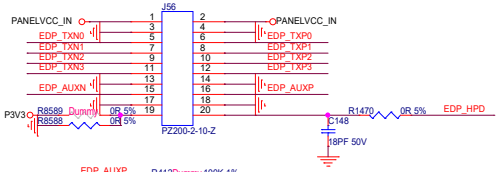
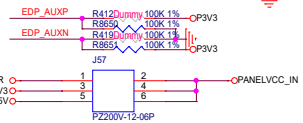
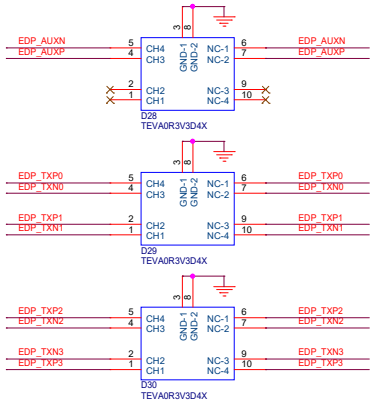
eDP

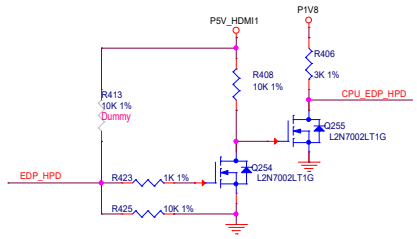




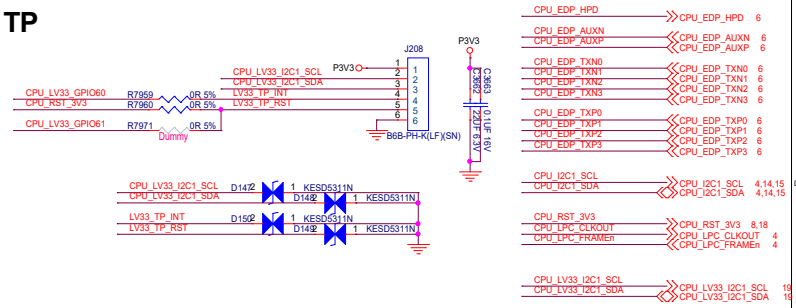


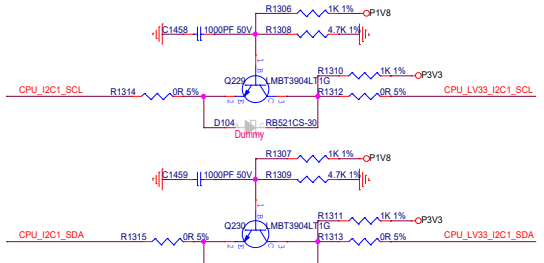


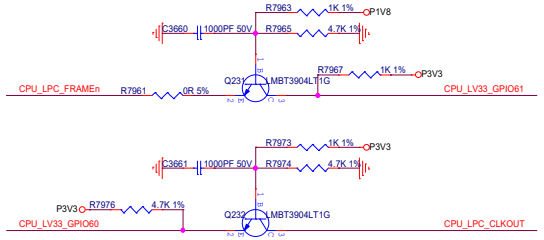




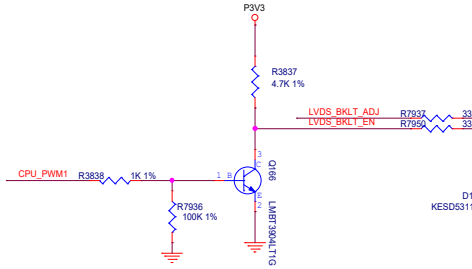
TP

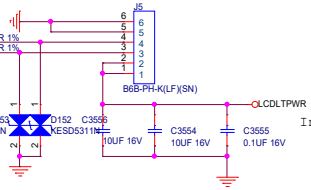




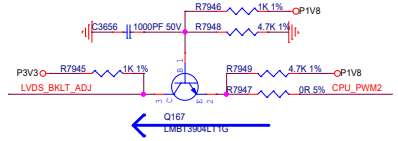


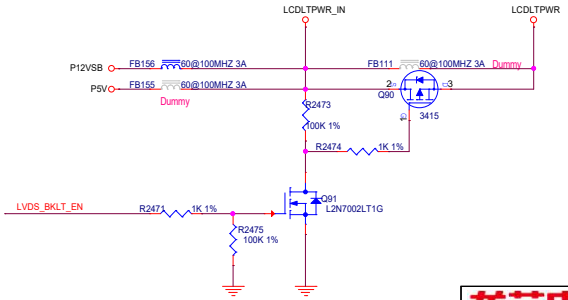
BACKLIGHT CONTROL





Inrush Current = 1.5A





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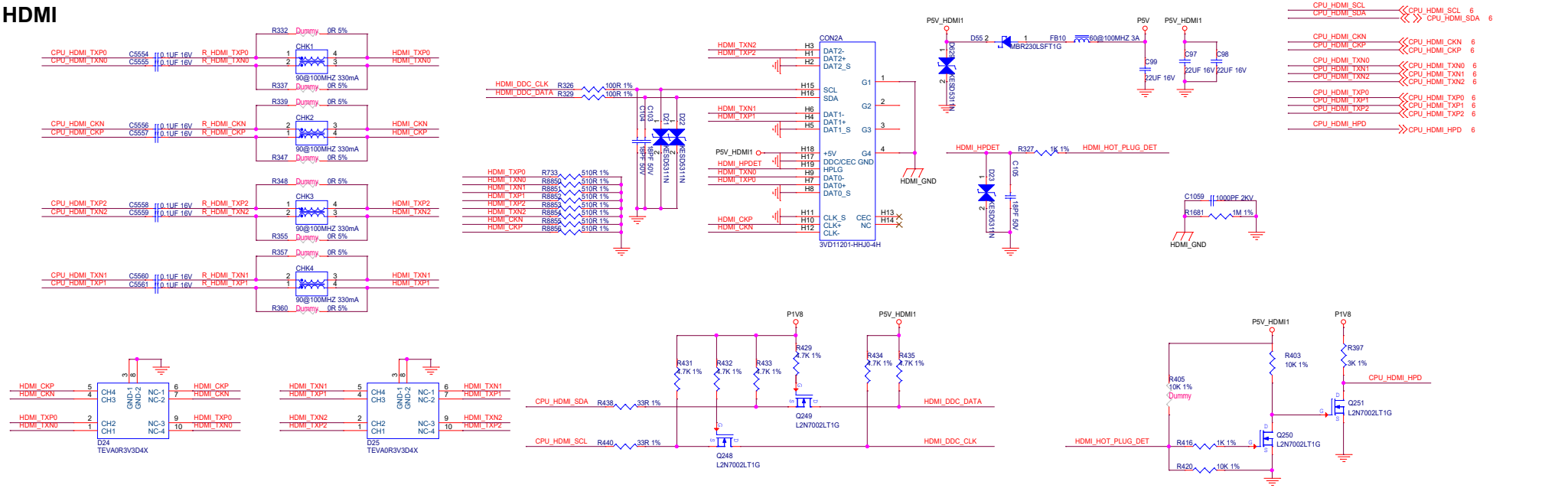
HDMI



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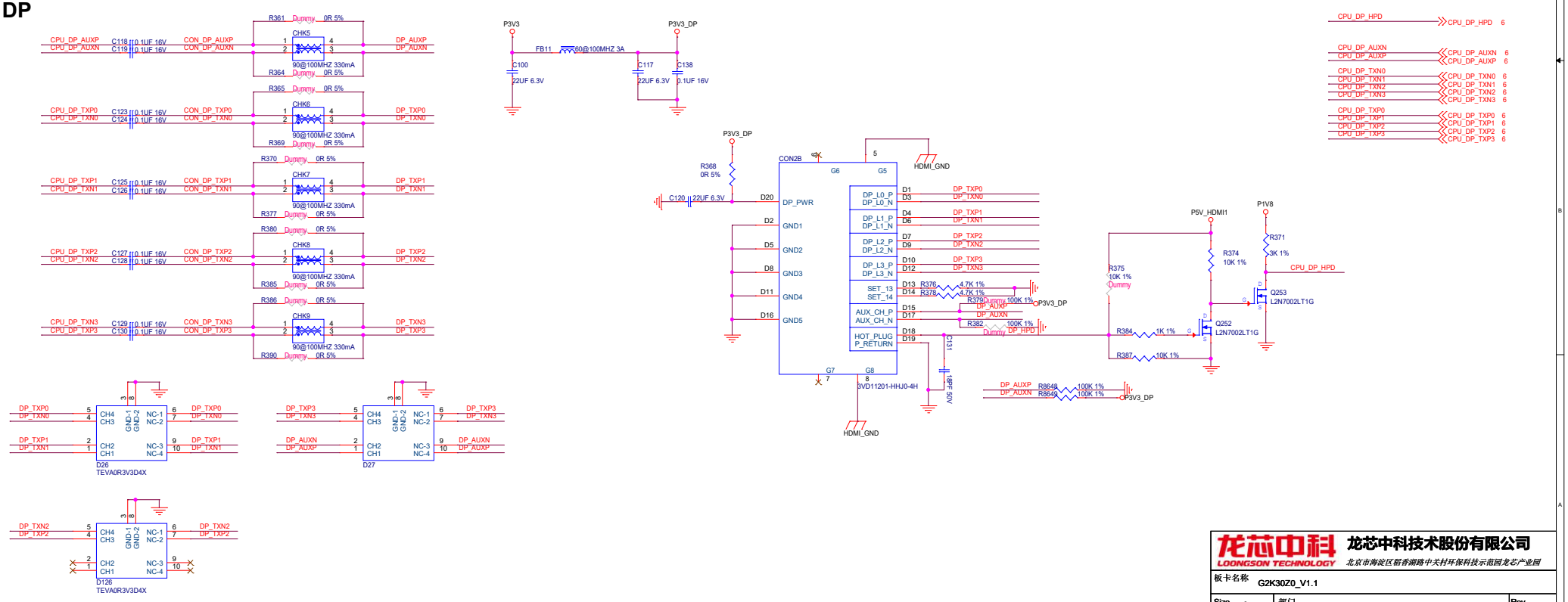

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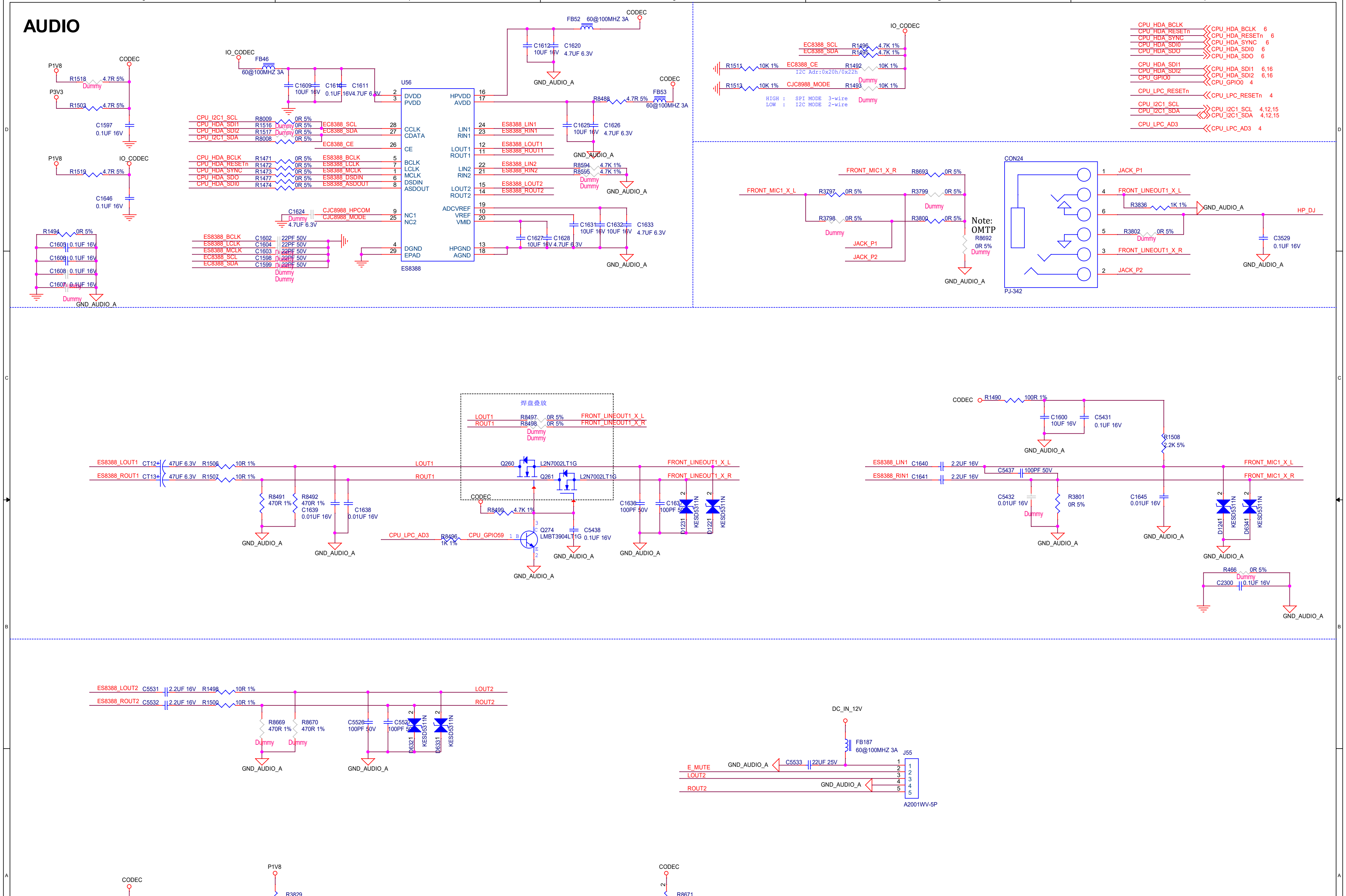
AUDIO



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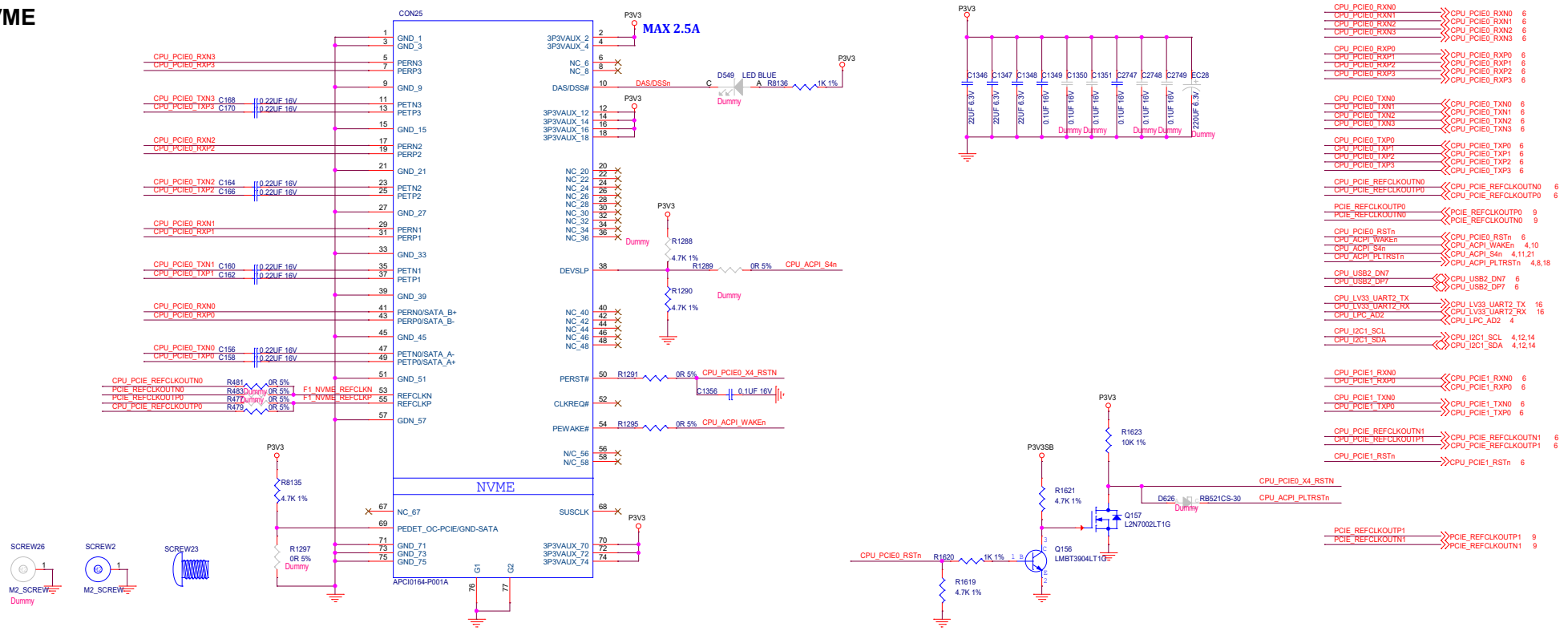
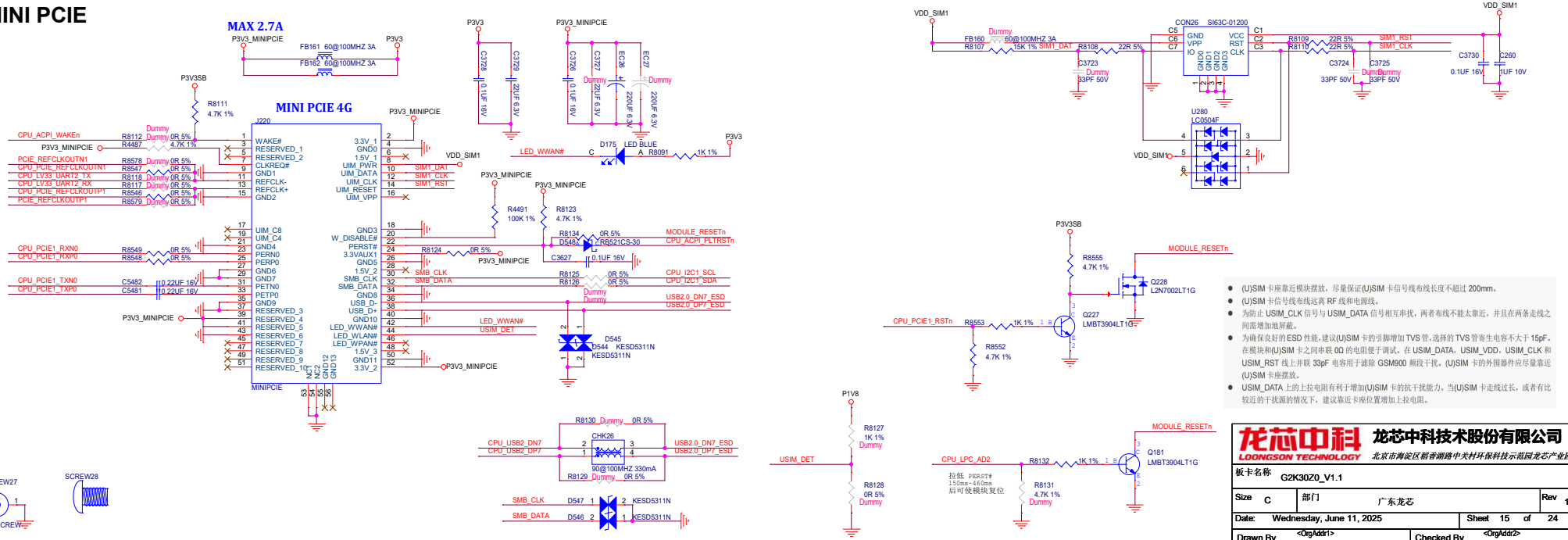
M.2 NVME



MINI PCIE



- (U)SIM 卡座靠近模块摆放，尽量保证(U)SIM 卡信号线布线长度不超过 200mm。
- (U)SIM 卡信号线布线远离 RF 线和电源线。
- 为防止 USIM_CLK 信号与 USIM_DATA 信号相互串扰，两者布线不能太靠近，并且在两条走线之间需增加地屏蔽。
- 为确保良好的 ESD 性能，建议(U)SIM 卡的引脚增加 TVS 管，选择的 TVS 管寄生电容不大于 15pF。在模块和(U)SIM 卡之间串联 0Ω 的电阻便于调试。在 USIM_DATA，USIM_VDD，USIM_CLK 和 USIM_RST 线上并联 33pF 电容用于滤除 GSM900 频段干扰。(U)SIM 卡的外围器件应尽量靠近(U)SIM 卡座摆放。
- USIM_DATA 上的上拉电阻有利于增加(U)SIM 卡的抗干扰能力。当(U)SIM 卡走线过长，或者有比较近的干扰源的情况下，建议靠近卡座位置增加上拉电阻。

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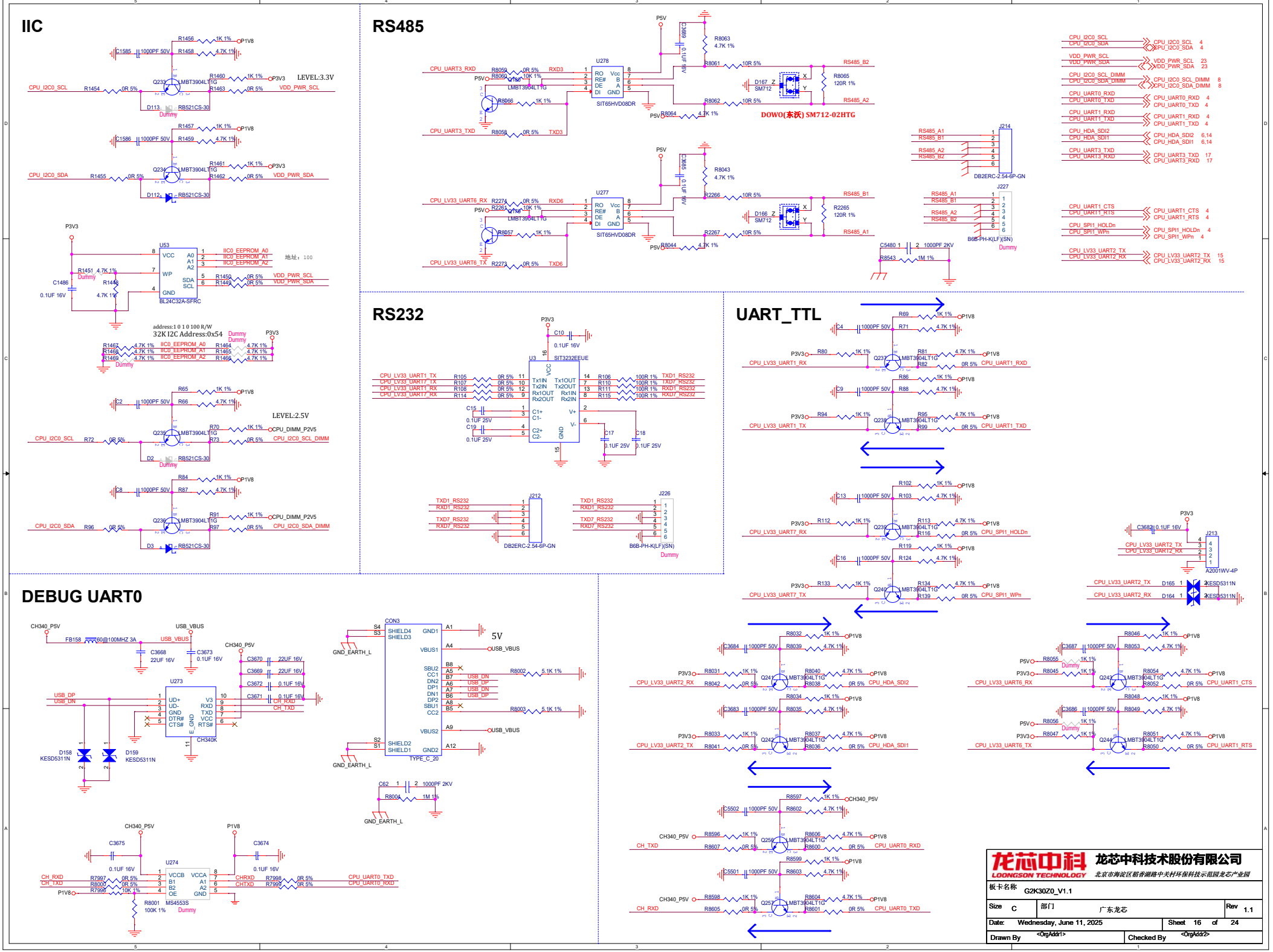
IIC
RS485
RS232
UART_TTL
DEBUG UART0
LEVEL:3.3V
LEVEL:2.5V
DOWO(东沃) SM712-02HTG
32K I2C Address:0x54
龙芯中科技术股份有限公司
LOONGSON TECHNOLOGY
北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园
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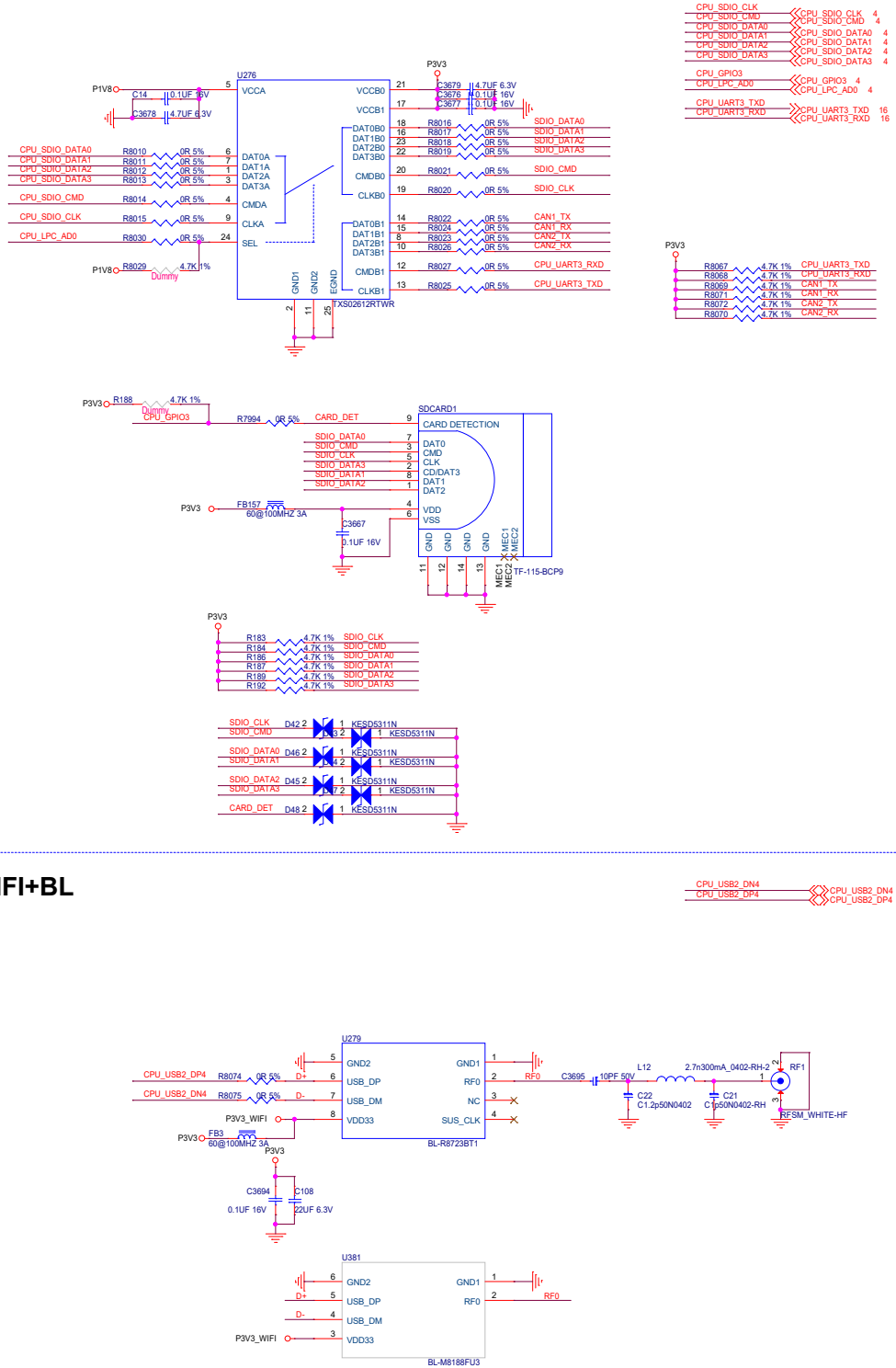
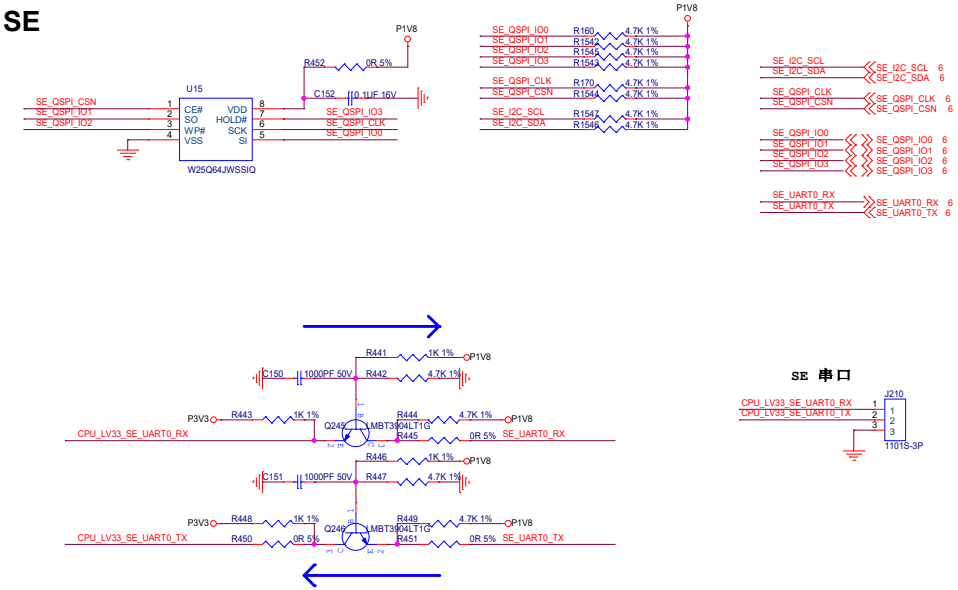
SDIO



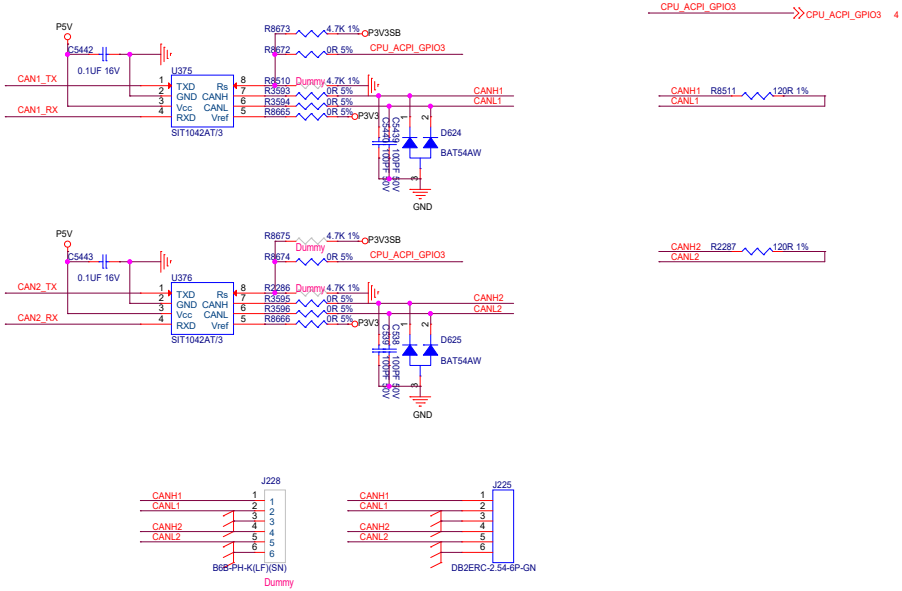
WIFI+BL

SE



SE 串口

CAN-FD



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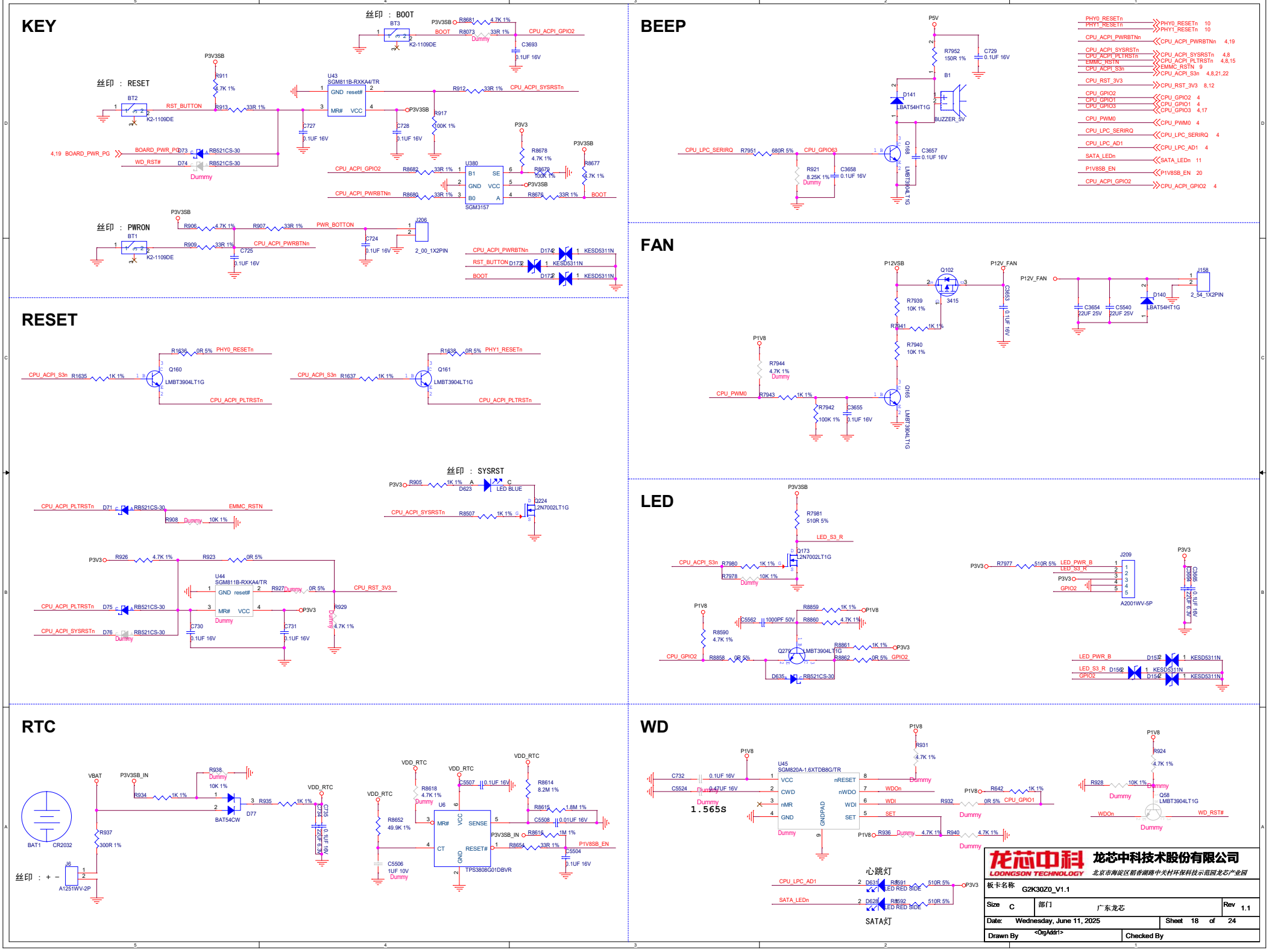
KEY
丝印 ： BOOT
BT3
P3V3SB
R8681 4.7K 1%
BOOT
R8073 33R 1%
Dummy
CPU_ACPI_GPIO2
C3693 0.1UF 16V
K2-1109DE
丝印 ： RESET
BT2
R911 4.7K 1%
RST_BUTTON
R913 33R 1%
U43
SGM811B-RXKA4/TR
GND reset#
MR# VCC
R912 33R 1%
CPU_ACPI_SYSRSTn
R917 100K 1%
C727 0.1UF 16V
C728 0.1UF 16V
4,19 BOARD_PWR_PG
BOARD_PWR_PG
WD_RST#
D73 RB521CS-30
D74 RB521CS-30
Dummy
P3V3
R8678 4.7K 1%
R8679 100K 1%
P3V3SB
R8677 4.7K 1%
CPU_ACPI_GPIO2
R8682 33R 1%
U380
B1 SE
GND VCC
B0 A
SGM3157
CPU_ACPI_PWRBTNn
R8680 33R 1%
R8676 33R 1%
BOOT
丝印 ： PWRON
BT1
R906 4.7K 1%
R907 33R 1%
PWR_BOTTON
J206
R909 33R 1%
CPU_ACPI_PWRBTNn
C725 0.1UF 16V
C724 0.1UF 16V
2_00_1X2PIN
CPU_ACPI_PWRBTNn
RST_BUTTON
BOOT
D172 KESD5311N
RESET
CPU_ACPI_S3n
R1635 1K 1%
R1636 0R 5%
PHY0_RESETn
Q160
LMBT3904LT1G
CPU_ACPI_PLTRSTn
R1637 1K 1%
R1638 0R 5%
PHY1_RESETn
Q161
丝印 ： SYSRST
P3V3
R905 1K 1%
D623
LED BLUE
Q224
2N7002LT1G
CPU_ACPI_SYSRSTn
R8507 1K 1%
CPU_ACPI_PLTRSTn
D71 RB521CS-30
EMMC_RSTN
R908 Dummy 10K 1%
P3V3
R926 4.7K 1%
R923 0R 5%
U44
SGM811B-RXKA4/TR
GND reset#
MR# VCC
R927 Dummy 0R 5%
CPU_RST_3V3
CPU_ACPI_PLTRSTn
D75 RB521CS-30
CPU_ACPI_SYSRSTn
D76 RB521CS-30
C730 0.1UF 16V
C731 0.1UF 16V
R929 4.7K 1%
RTC
VBAT
P3V3SB_IN
R938 Dummy 10K 1%
R934 1K 1%
R935 1K 1%
D77
BAT54CW
R937 300R 1%
BAT1 CR2032
丝印 ： + −
J6
A1251WV-2P
VDD_RTC
C724 C725 10UF 6.3V
R8618 4.7K 1%
C5507 0.1UF 16V
R8614 8.2M 1%
U6
R8615 1.8M 1%
R8652 49.9K 1%
C5508 0.01UF 16V
R8616 1M 1%
P3V3SB_IN
R8654 33R 1%
P1V8SB_EN
C5504 0.1UF 16V
C5506 1UF 10V
Dummy
MR# VCC
SENSE
CT GND RESET#
TPS3808G01DBVR
BEEP
P5V
R7952 150R 1%
C729 0.1UF 16V
B1
D141 LBAT54HT1G
BUZZER_5V
CPU_LPC_SERIRQ
R7951 680R 5%
CPU_GPIO63
R921 8.25K 1%
Dummy
C3658 0.1UF 16V
Q169
LMBT3904LT1G
C3657 0.1UF 16V
PHY0_RESETn
PHY1_RESETn
CPU_ACPI_PWRBTNn
CPU_ACPI_SYSRSTn
CPU_ACPI_PLTRSTn
EMMC_RSTN
CPU_ACPI_S3n
CPU_RST_3V3
CPU_GPIO2
CPU_GPIO1
CPU_GPIO3
CPU_PWM0
CPU_LPC_SERIRQ
CPU_LPC_AD1
SATA_LEDn
P1V8SB_EN
CPU_ACPI_GPIO2
FAN
P12VSB
Q102
P12V_FAN
3415
C5653 0.1UF 16V
R7939 10K 1%
R7941 1K 1%
R7940 10K 1%
P1V8
R7944 4.7K 1% Dummy
CPU_PWM0
R7943 1K 1%
R7942 100K 1%
C3655 0.1UF 16V
Q165
LMBT3904LT1G
J158
2_54_1X2PIN
D140
LBAT54HT1G
C3654 22UF 25V
C5540 22UF 25V
LED
P3V3SB
R7981 510R 5%
LED_S3_R
Q173
2N7002LT1G
CPU_ACPI_S3n
R7980 1K 1%
R7978 10K 1% Dummy
P1V8
R8859 1K 1%
C5562 1000PF 50V
R8860 4.7K 1%
R8590 4.7K 1%
CPU_GPIO2
R8858 0R 5%
Q279
LMBT3904LT1G
R8861 1K 1%
R8862 0R 5%
GPIO2
D635 RB521CS-30
P3V3
R7977 510R 5%
LED_PWR_B
LED_S3_R
GPIO2
J209
A2001WV-5P
C3666 22UF 6.3V
LED_PWR_B
LED_S3_R
GPIO2
D157 KESD5311N
D152 KESD5311N
WD
P1V8
C732 0.1UF 16V
C5524 Dummy 0.47UF 16V
Dummy
1.565S
U45
SGM820A-1.6XTDB8G/TR
VCC
CWD
nMR
GND
GNDPAD
nRESET
nWDO
WDI
SET
R931 4.7K 1%
Dummy
WDOn
WDI
SET
R932 0R 5% CPU_GPIO1
R642 1K 1%
R936 Dummy 4.7K 1%
R940 4.7K 1%
Dummy
R924 4.7K 1%
R928 10K 1%
Dummy
Q58
LMBT3904LT1G
WDOn
WD_RST#
心跳灯
SATA灯
CPU_LPC_AD1
SATA_LEDn
D631 D632
R8591 R8592
510R 5%
LED RED SIDE
P3V3
龙芯中科技术股份有限公司
北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园
板卡名称 G2K30Z0_V1.1
Size C
部门 广东龙芯
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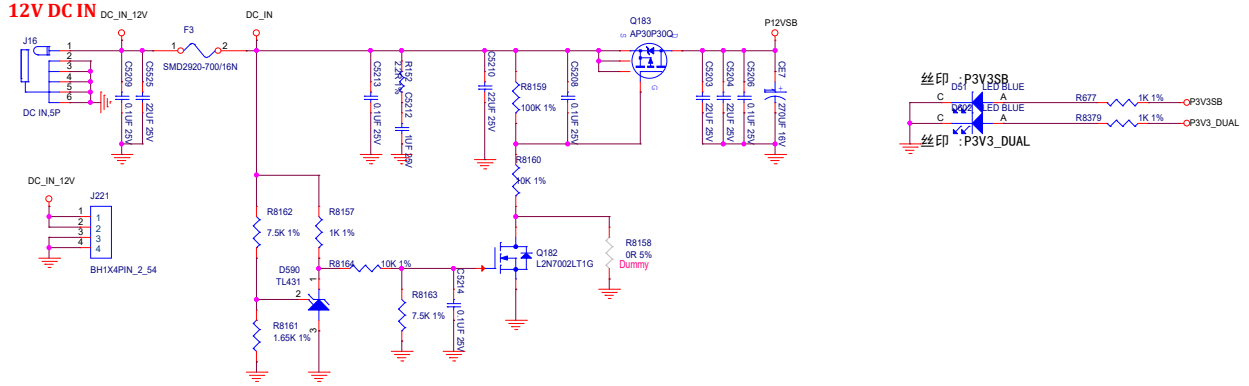
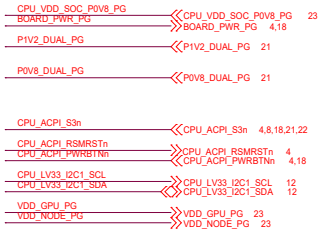
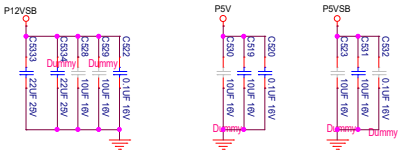
DC_IN







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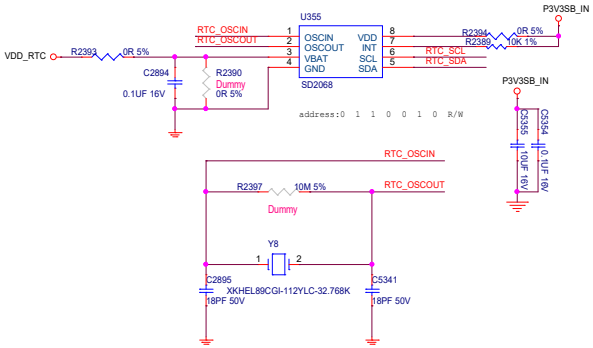

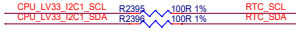

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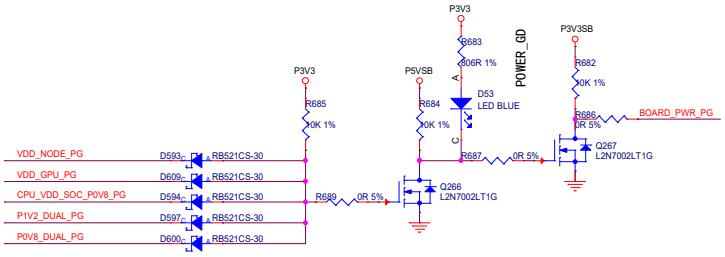

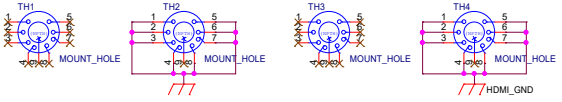

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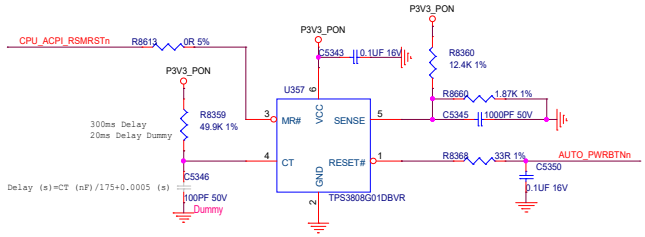

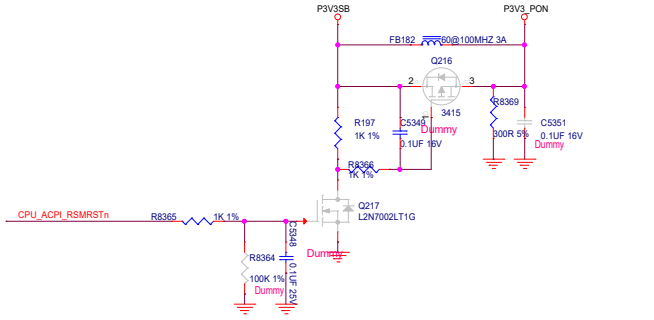

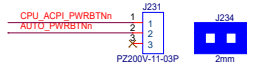

POWER_ON	
1-2	AUTO
2-3	NORMAL

龙芯中科 LOONGSON TECHNOLOGY 龙芯中科技术股份有限公司
北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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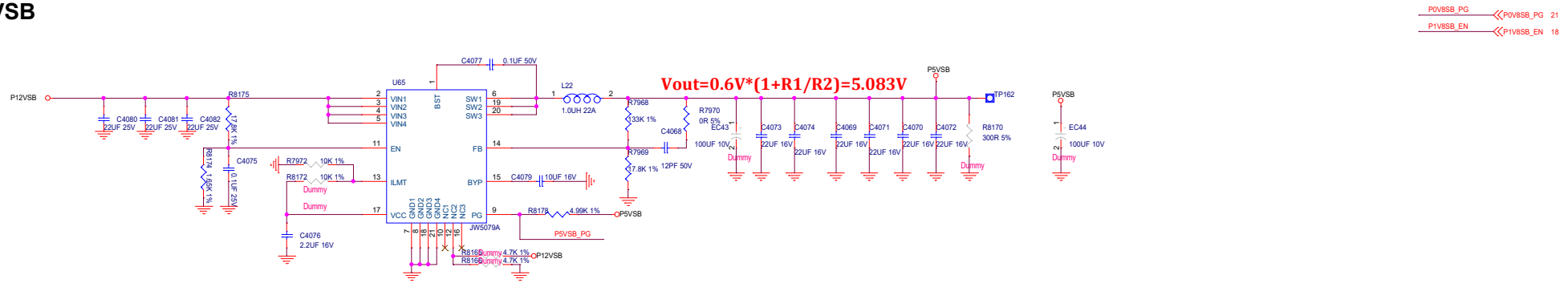
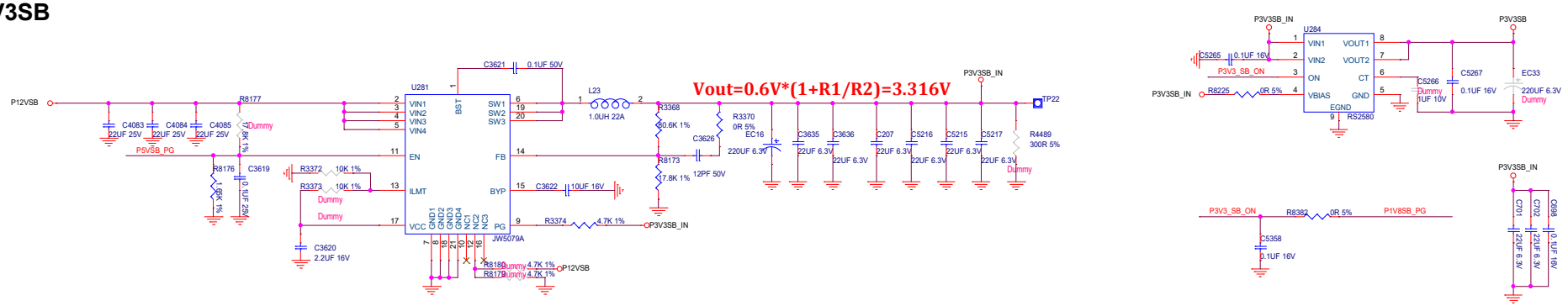
P5VSB



P3V3SB



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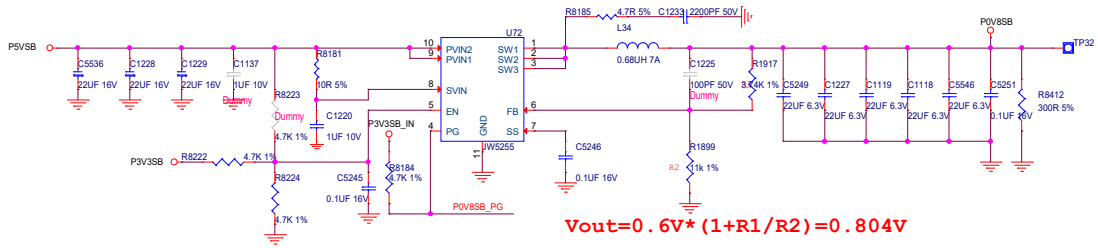

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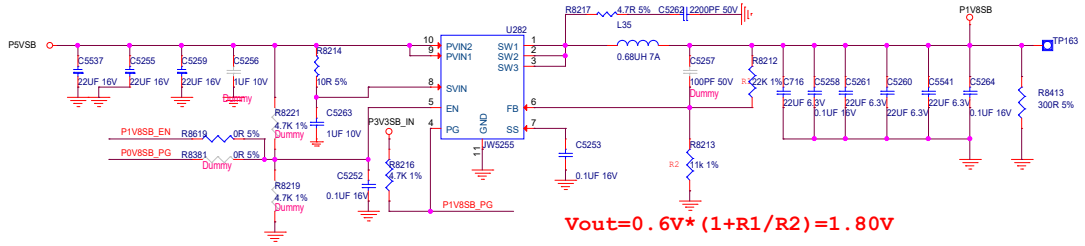

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板卡名称	G2K30Z0_V1.1		
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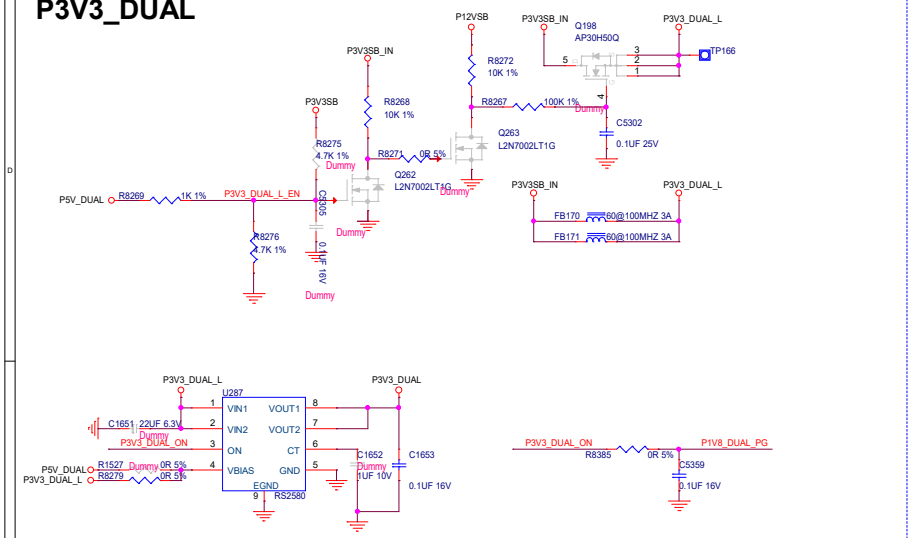
Drawn By <OrgAddr1>		Checked By <OrgAddr2>	

P3V3_DUAL



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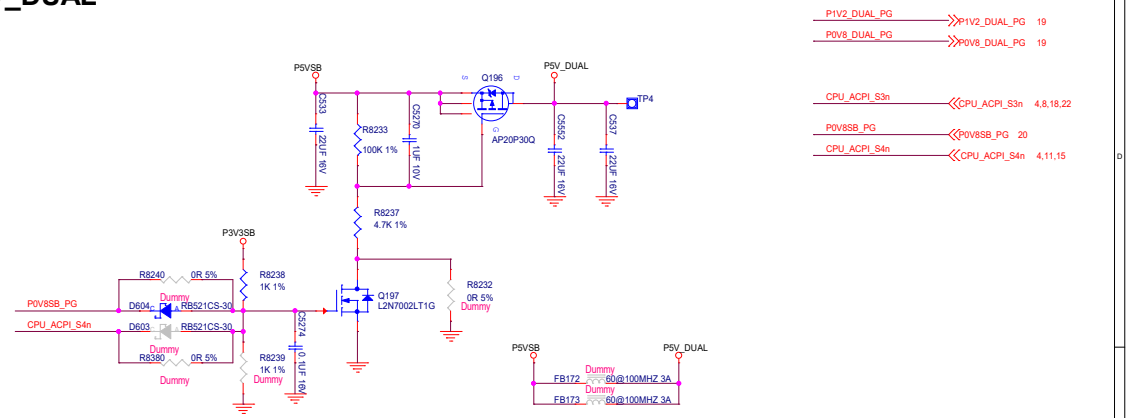

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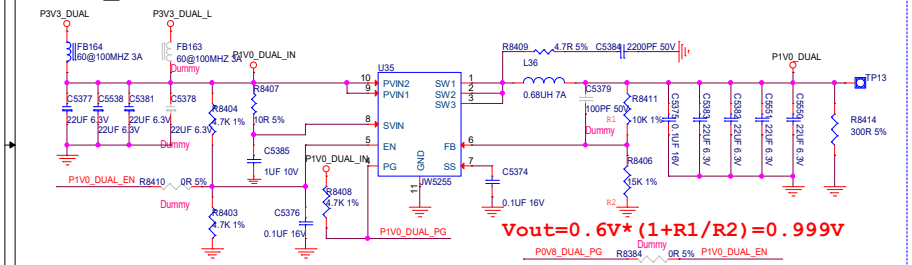

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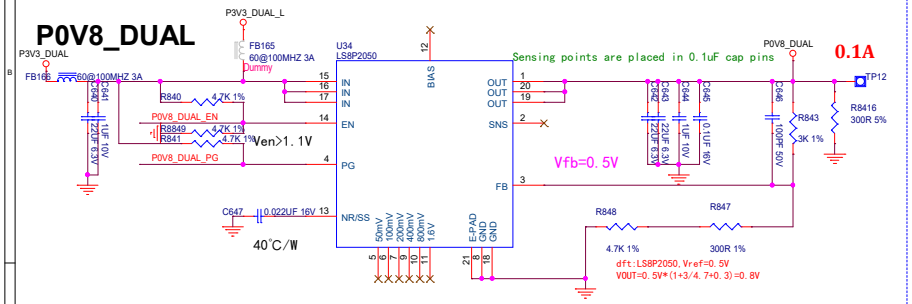

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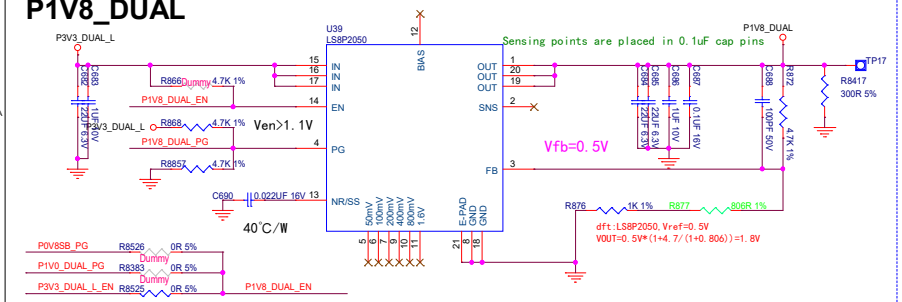
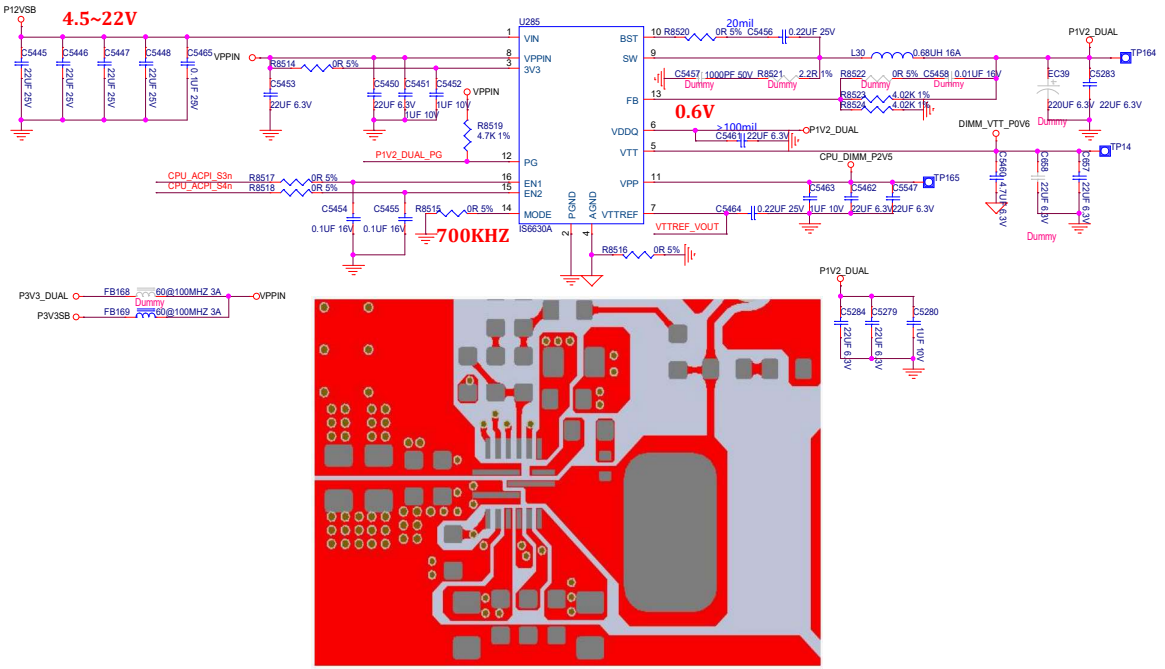
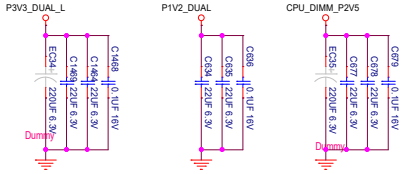


P1V2_DUAL DIMM_VTT_P0V6 CPU_DIMM_P2V5





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龙芯中科技术股份有限公司

北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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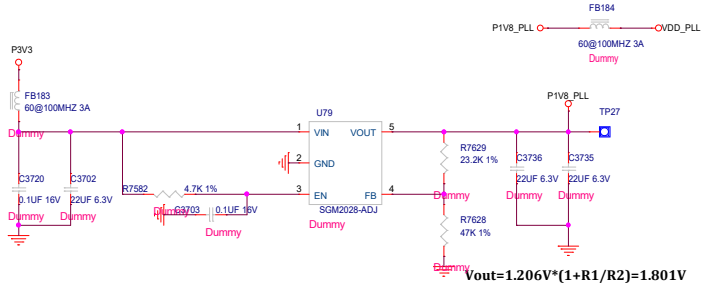
P1V8_PLL



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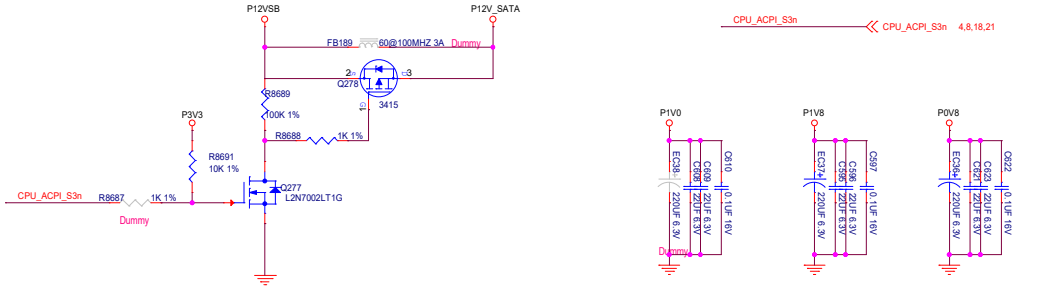

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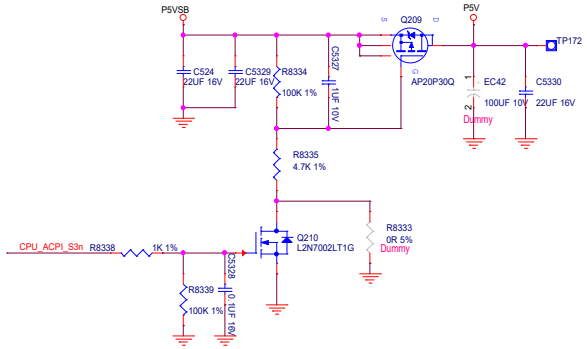

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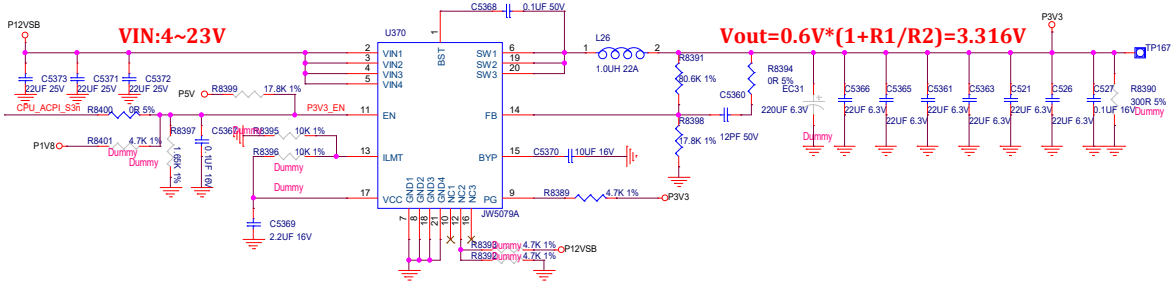

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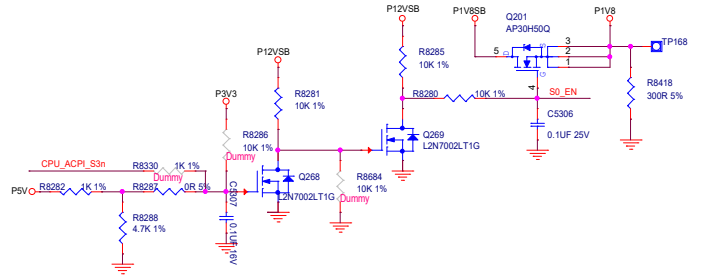
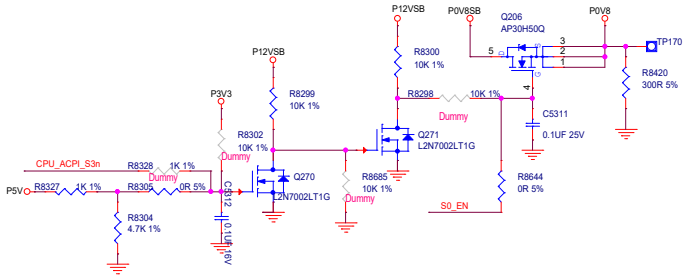


P0V8



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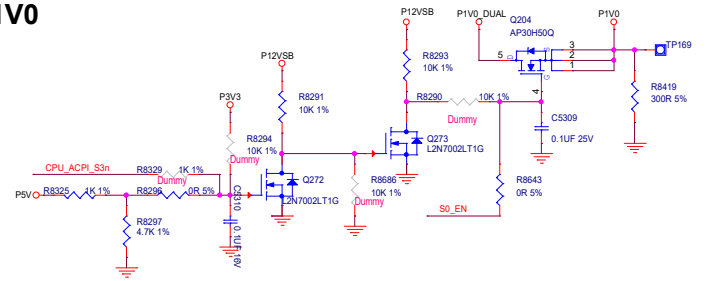

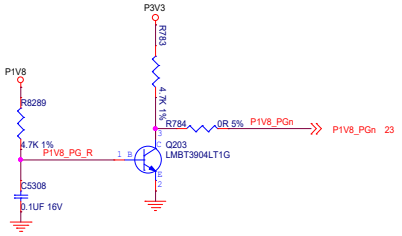

龙芯中科 LOONGSON TECHNOLOGY

龙芯中科技术股份有限公司

北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

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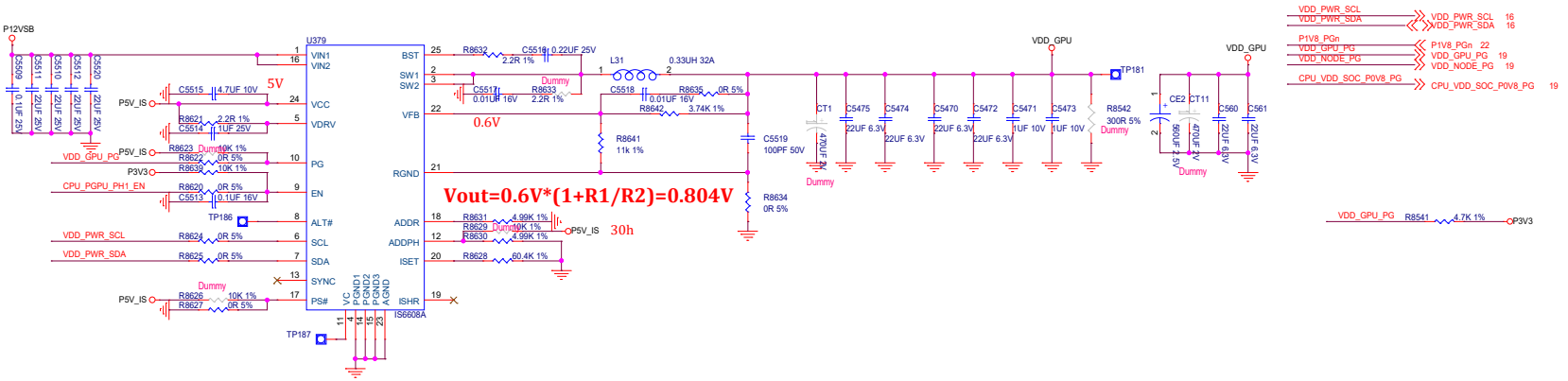
VDD_GPU



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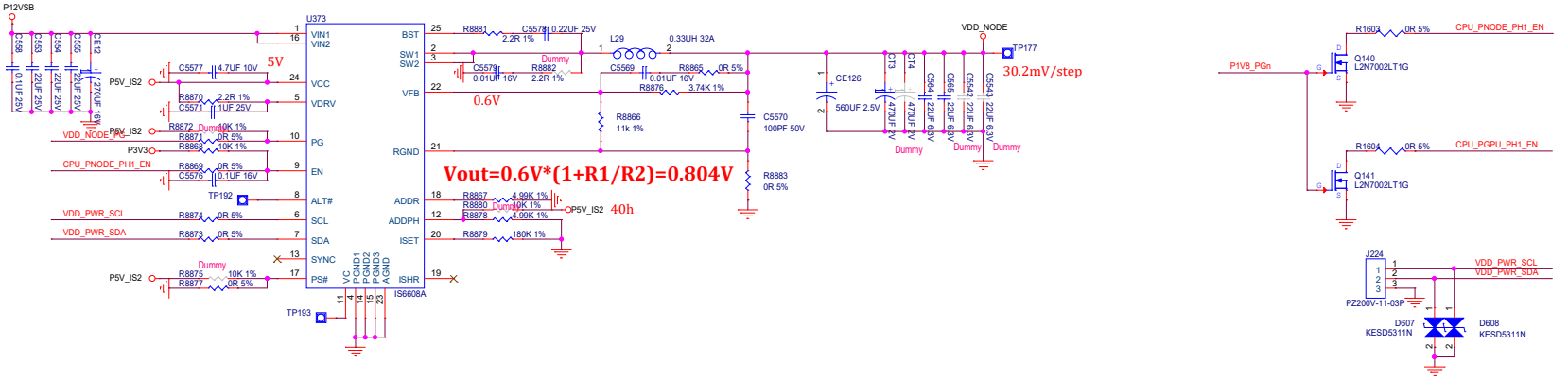

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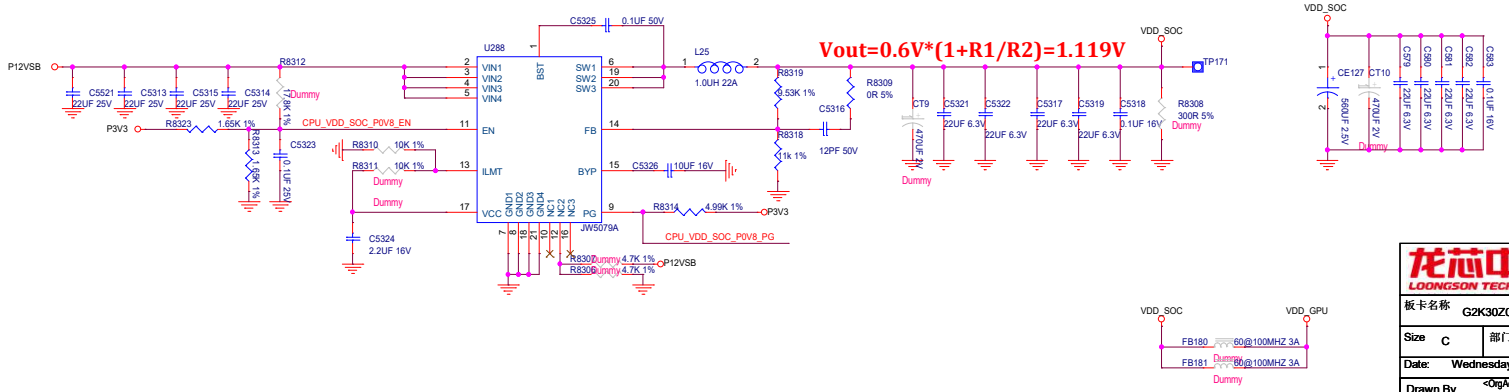

龙芯中科 LOONGSON TECHNOLOGY	龙芯中科技术股份有限公司 北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园		
板卡名称	G2K30Z0_V1.1		
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REVISON HISTORY

龙芯中科 LOONGSON TECHNOLOGY

龙芯中科技术股份有限公司

北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园

板卡名称 G2K30Z0_V1.1			
Size C	部门 广东龙芯		Rev 1.1
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